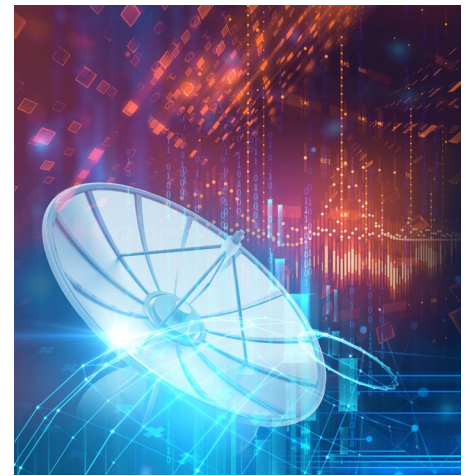


Model 875 Vector Signal Generator



Features

- Excellent Phase Noise
- Ultra-Fast Switching
- Ultra High I/Q data Rates, Deep Internal Memory
- Various Digital Modulation Supported

Applications

- Arbitrary I/Q Waveform
- Radar Signal Simulation
- Receiver Testing
- Avionic Modulation Emulation
- High Speed Antenna Testing



Model 875 Datasheet v1.25

10 MHz to 4, 6, 12, 20, and 40 GHz
Single and Multi-Channel
Ultra-Agile Vector Signal Generators

DEFINITIONS

The specifications in the following pages describe the warranted performance of the instrument for 23 ± 5 °C after a 30-minute warm-up period.

Typical: Expected mean values, not warranted performance

Min and max: Parameter range that is guaranteed by product design, and/or production tested. Warranted performance specifications include guard-bands to account for the expected statistical performance distribution, measurement uncertainties, and changes in performance due to environmental conditions.

INTRODUCTION

Ultra-Agile Vector Signal Generator

The 875 is an ultra-fast-switching vector-modulated signal generator series covering a continuous frequency ranges from 10 MHz to 4, 6, 12, 20, or 40 GHz, respectively, with 0.001 Hz resolution, and 400 MHz RF modulation bandwidth.

The 875-X-X is the corresponding multi-channel product series.

A high performance internal I/Q modulator enables customized waveforms as modulation signals and supports variety of modulation schemes including avionics modulation. The internal dual channel arbitrary waveform generator fitted ensures carrier suppression of >80 dB and image suppression of >75 dB.

The standard 875 enables ultra-fast CW frequency sweeping, chirping, intra-pulse modulation, pulse shaping with very low phase noise.

Among others, the following use cases are supported:

- Upload multiple formats of IQ Data into 875 Memory. An 875 GUI supports data formats from various vendors. The internal RAM can store up to 512 MS (32 bits per I/Q sample) of IQ data. The 875 internal AWG can play selected sections of the RAM upon a user trigger.
- Use 875 to synthesize and play predefined digital modulation formats (option IVM)
- Use the analog I/Q inputs (option AIQ) with up to 250 MHz analog bandwidth.
- Use FCP interface (option FCP) to:
 - live stream digital I/Q data.
 - instantaneously switch between pre-loaded I/Q data segments.
 - control for ultra-fast frequency hopping (additionally, option UFS required).

All 875s operate with an ultra-stable temperature compensated frequency reference (OCXO) that can be phase-locked to an external reference.

The compact unit allows for full front panel control via touch panel display, and PC GUI Software supported operation via ETHERNET, USB, FCP and GPIB communication ports.

FACTS & FIGURES & SPECIFICATIONS

Signal Specifications

PARAMETER	MIN	TYPICAL	MAX	NOTE
Frequency Range	10 MHz		4 GHz 6 GHz 12 GHz 20 GHz 40 GHz	875-4 875-6 875-12 875-20 875-40
Frequency Resolution		0.001 Hz		
Phase Resolution		0.01 deg		
Frequency & Amplitude Switching / Settling Time		1.5 ms 500 μ s 200 ns 800 ns		valid signal after SCPI received List sweep within 400 MHz BW, Option UFS within entire frequency range, Option UFS
Output Power Level				See Figures
10 to 100 MHz >0.1 GHz	-65 dBm		+13 dBm +17 dBm	875-4
0.1 to 6 GHz	-60 dBm		+15 dBm	875-6
0.1 to 12 GHz	-60 dBm		+15 dBm	875-12
0.1 to 5 GHz 5 to 10 GHz 10 to 20 GHz	-60 dBm		+18 dBm +20 dBm +14 dBm	875-20
0.1 to 5 GHz 5 to 10 GHz 10 to 20 GHz 20 to 30 GHz 30 to 36 GHz 36 to 40 GHz	-60 dBm		+18 dBm +20 dBm +14 dBm +10 dBm +6 dBm	875-40
Power Resolution		0.01 dB		
Power Level Uncertainty				See Figure 5
<4 GHz		0.25 dB	0.7 dB	Digital ALC on, >-20dBm
4 to 6 GHz		0.3 dB	1.0 dB	
6 to 20 GHz		0.3 dB	1.3 dB	
20 to 40 GHz			1.5 dB	
<4 GHz		0.3 dB	0.8 dB	Pmin to -20 dBm
4 to 6 GHz		0.35 dB	1.2 dB	
6 to 20 GHz		0.4 dB	1.3 dB	
20 to 40 GHz			1.5 dB	
Reverse Power Protection				
DC Voltage			\pm 10 V	
RF Power			26 dBm	
Output Impedance		50 Ω		
VSWR		1.8		See Figure
SSB Phase Noise at 1 GHz and 10 dBm				See Figures 1, 2
at 10 Hz from carrier		-87 dBc/Hz -100 dBc/Hz		Option LN
at 1 kHz from carrier		-130 dBc/Hz		
at 20 kHz from carrier		-145 dBc/Hz		
at 100 kHz from carrier		-150 dBc/Hz		
SSB Phase Noise at 4 GHz and 10 dBm				See Figures 1, 2
at 10 Hz from carrier		-74 dBc/Hz -90 dBc/Hz		Option LN
at 1 kHz from carrier		-121 dBc/Hz		
at 20 kHz from carrier		-133 dBc/Hz		
at 100 kHz from carrier		-138 dBc/Hz		
SSB Phase Noise at 10 GHz and 10 dBm				See Figures 1, 2
at 10 Hz from carrier		-60 dBc/Hz -75 dBc/Hz		Option LN
at 1 kHz from carrier		-85 dBc/Hz		

at 20 kHz from carrier		-100 dBc/Hz		
at 10 MHz from carrier		-118 dBc/Hz		
SSB Phase Noise at 20 GHz and 10 dBm				See Figures 1, 2
at 10 Hz from carrier		-61 dBc/Hz -74 dBc/Hz		Option LN
at 1 kHz from carrier		-100 dBc/Hz		
at 20 kHz from carrier		-95 dBc/Hz		
at 10 MHz from carrier		-113 dBc/Hz		
Harmonics @ 0 dBm 0.01 to 4 GHz		-45 dBc	-40 dBc	875-4
Harmonics @ 0 dBm 0.01 to 4 GHz 4 to 7 GHz 7 to 12 GHz		-45 dBc -35 dBc -55 dBc	-40 dBc -30 dBc -50 dBc	875-6 / 12
Harmonics @ 0 dBm 0.01 to 5 GHz 5 to 20 GHz >20 GHz		-50 dBc -35 dBc -35 dBc	-45 dBc -30 dBc -30 dBc	875-20 / 40
Non-Harmonic Spurious (at 0 dBm output, > 10 kHz offset)		-90 dBc -80 dBc -80 dBc -70 dBc -60 dBc -55 dBc	-75 dBc -70 dBc -50 dBc -50 dBc -50 dBc -45 dBc	< 1.2 GHz 1.2 to 2.5 GHz 2.5 to 4 GHz 4 to 12 GHz 12 to 20 GHz > 20 GHz

I/Q Modulator

PARAMETER	MIN	TYPICAL	MAX	NOTE
RF modulation bandwidth		400 MHz		
IQ Frequency response				Over full IQ bandwidth
< 10 GHz		<±1.0 dB		
10 to 30 GHz		<±2.0 dB		
30 to 40 GHz		<±3.5 dB		
Carrier leakage		-90 dBc	-70 dBc	
Image sideband rejection		-85 dBc	-65 dBc	

Internal I/Q Baseband Generator

PARAMETER	MIN	TYPICAL	MAX	NOTE
Sample resolution		16 bits		each I and Q
Clock source		Internal		
Sample rate	10 Hz		500 MHz	
Sample rate resolution		1 Hz		
Waveform length	96 Sa 246 Sa		512 MSa 334 MSa	* Marker signals active
External trigger to RF output delay		tbu		500 MHz clock rate
Segment mode				
Number of segments	1		65536	
Segment changeover		Seamless, immediate		
Trigger modes		tbd: Same segment, next segment, addressed segment		
Sequencer play list length	1		2048	
Sequency segment repetitions	1		tbd	
Changeover time		tbd (meas)		500 MHz sample rate, external trigger, immediate segment changeover
Marker signals		Markers are defined during the waveform generation process.		
Number of markers		4		
Type		waveform		
Marker outputs		MF1 Out, MF2 Out		Selectable, see chapter MULTI FUNCTION OUTPUTS
Marker delay setting range		tbd		
Marker delay setting resolution		tbd		
Marker duration minimum value		1 sample 4 samples		Sample rate <= 125 MSa Sample rate > 125 MSa
Marker duration variation			+/- 8 ns +/- 1 sample	
Marker jitter			+/- 8 ns +/- 1 sample	
Marker polarity		Normal / inverted		
Marker output to RF output delay		typ. - 367 ns		

* Shorter Waveforms will be automatically extended by cyclically repeating the waveform.

Internal Vector Modulation (Option IVM)

PARAMETER	MIN	TYPICAL	MAX	NOTE
Modulation schemes	8QAM, 16QAM, 32QAM, 64QAM, 128QAM, 256QAM, 512QAM, 1024QAM, 2048QAM, 4096QAM			
Symbol rate	10 S/s		200 MS/s	
Basband Filter	cosine, root cosine, Gaussian, rectangular, Dirac, rectangular asymmetric			
Filter parameter range				
Cosine, root cosine (parameter α)	0.05		1	
Gaussian (parameter $B \times T$)	0.05		2.5	
Data source	PRBS generator, user data list			
Data lists	8 bits		tdb	

Multicarrier Generation (Option IVM)

PARAMETER	MIN	TYPICAL	MAX	NOTE
Number of carriers	1		1024	
Frequency offset	-200 MHz		200 MHz	
Power offset	-60 dB		0 dB	0.1 dB resolution
Tone initial phase offset	0 deg		360 deg	0.1 deg resolution

Avionics Modulation (Option AVIO)

PARAMETER	MIN	TYPICAL	MAX	NOTE
AVIO Modulation DME				
Operating modes	interrogation & reply			
DME channel	X, Y			
Frequency range	960 MHz		1215 MHz	
Pulse on/off ratio		80 dB	70 dB	
Pulse rise/fall times	100 ns		50 μ s	100 ns resolution
Pulse width	100 ns		50 μ s	100 ns resolution
Pulse spacing	100 ns		300 μ s	100 ns resolution
Pulse rate	10 Hz		10 kHz	1 Hz resolution
Pulse shaping	cos, \cos^2 linear, gauss			individually settable for rising & falling edge
ID code		tdb		
ID rate		tdb		
AVIO Modulation VOR	108 MHz		118 MHz	
Bearing accuracy	$\pm 2\% / \pm 0.5$ deg			
Subcarrier frequency accuracy	9960 \pm 2 Hz			
AM accuracy	30 \pm 1%			
AM distortion (THD)			2%	
FM accuracy	480 \pm 1 Hz			
AVIO Modulation ILS	108 MHz		112 MHz	
AM accuracy	40 \pm 1%			
AM distortion			0.5%	
DDM resolution		0.0002 0.0004		Localizer Glide Slope
DDM accuracy		0.0004 0.0008		Localizer Glide Slope
Marker Beacon				
AM tone accuracy (95% AM)		5% of setting		
AM tone distortion (95% AM)		5%		



Analog Modulation (Option MOD)

PARAMETER	MIN	TYPICAL	MAX	NOTE
Pulse Modulation				
Modulation source	internal Pulse Generator/ external			
Modulator	RF (internal/external) or Baseband (BB, internal)			
Pulse rise/fall time		5 ns		10% / 90% of amplitude
On/off ratio	40 dB 90 dB 50 dB TBD dB	45 dB 95 dB 50 dB TBD dB		BB pulse modulator <4 GHz RF pulse modulator >4 GHz RF pulse modulator
Pulse overshoot			1 dB	
Video feedthrough		tbd		
Polarity / video polarity	normal / inverted			independently selectable
External pulse input to video output delay		20ns (meas)		
Video output to RF output delay		5ns (meas) 350ns (meas)		RF modulator BB modulator
External trigger to video output delay		TBD		
Pulse jitter (internal source)			<1 ps	
Internal Pulse Generator				
Pulse Mode	single pulse			
Pulse period setting range	16ns		10s	
Pulse period setting resolution		8ns		
Pulse width setting range	0ns		10s	
Pulse width setting resolution		8ns		
Pulse width accuracy		same as time base		
Amplitude Modulation				
Modulation source		Internal / External		External requires option AIQ
Modulation depth	0%		100%	Output is clipped at max power level
Deviation accuracy		0.1%	1%	1 kHz rate, 80% depth
Deviation resolution		0.1%		
Distortion (THD)			1%	1 kHz rate, 80% depth
Modulation frequency range	0.1 Hz		100 MHz	
Modulation waveforms		Sine, Square		
Frequency Modulation				
Modulation source		Internal / External		External requires option AIQ
Maximum frequency deviation (peak)	200 MHz			
Deviation accuracy		0.5%	1%	
Distortion (THD)		< 1 %		1 kHz rate, 10 kHz deviation
Modulation frequency range	0.1 Hz		100 MHz	
Modulation waveforms	Sine			
Phase Modulation				
Modulation source		Internal / External		External requires option AIQ
Phase deviation (peak)	0		100 rad	
Deviation accuracy		0.5%	1%	
Modulation frequency range	0.1 Hz		100 MHz	
Modulation waveforms	Sine			
Distortion (THD)		< 1%		1 kHz rate & N x rad deviation

Frequency Reference

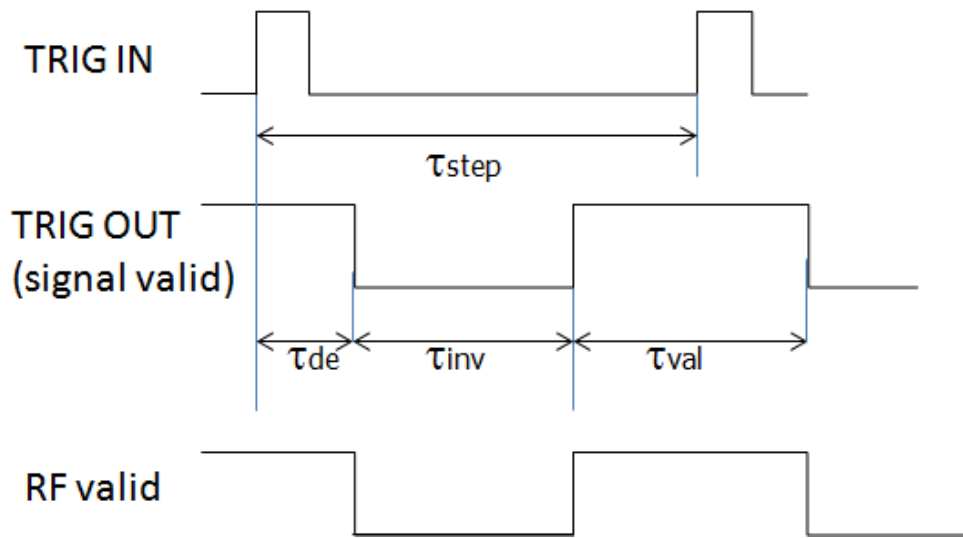
PARAMETER	MIN	TYPICAL	MAX	NOTE
Internal Reference Frequency		100 MHz 10 MHz		Option LN
Initial calibrated accuracy			±10 ppb	At 23 ± 3 °C
Temperature stability			±100 ppb ±20 ppb	0 to 50 °C Option LN
Aging after 1 st year			1 ppm 0.03 ppm	Option LN
Aging per day			5 ppb 0.5 ppb	after 30 days operation Option LN
Warm-up time	5 min			
Output of internal reference	10 MHz or 100 MHz			
Output power	0 dBm			
Output impedance	50 Ω			
High Performance Phase Synchronization Clock	3 GHz			
Phase Lock to External Reference	5 MHz		250 MHz	Option VREF
External reference frequency resolution	1 MHz			Option VREF
Reference Input Level				
10 MHz or 1-250 MHz	-5 dBm	0 dBm	+10 dBm	
Lock Range				
10 MHz or 1-250 MHz			±1.5 ppm	
Reference Input Impedance		50 Ω		

Sweeping Capability

PARAMETER	MIN	TYPICAL	MAX	NOTE
Sweep Type	List, linear, logarithmic, sawtooth, triangle, random			
Frequency Sweep Range	Full range			
Sweep Parameters	Frequency, power, phase			
Step time (t_{step})	500 μs 200 ns 800 ns		19998 s 19998 s	Option UFS, within +/- 200 MHz Option UFS, within full range
Settling time (t_{inv})				To stabilize phase and amplitude, depends on frequency step
Time resolution		2 ns		
Timing accuracy per point		2 ns		

Trigger Capability

PARAMETER	MIN	TYPICAL	MAX	NOTE
Trigger Types	Continuous, single (point), gated, gated direction			
Trigger Source	External, bus (LAN, USB, GPIB)			
Trigger Modes	Continuous free run (AUTO), trigger and run, reset and run			
Trigger uncertainty		+/- 8 ns		
External trigger delay	0		10 s	Settable
External delay resolution		2 ns		
Trigger Polarity	Rising, falling			



External Multi-Function Inputs

PARAMETER	MIN	TYPICAL	MAX	NOTE
Connector Type	MF1 IN, MF2 IN			see chapter CONNECTORS, IOS
Application	Ext Pulse, Ext trigger			
Nominal input impedance	DC 10k Ω and AC 50 Ω (nom)			
Threshold voltage	0.85V	0.9 V	0.95 V	
Nominal input voltage	0 V		3.3 V	TTL compatible
Hysteresis		60 mV		

External Multi-Function Outputs

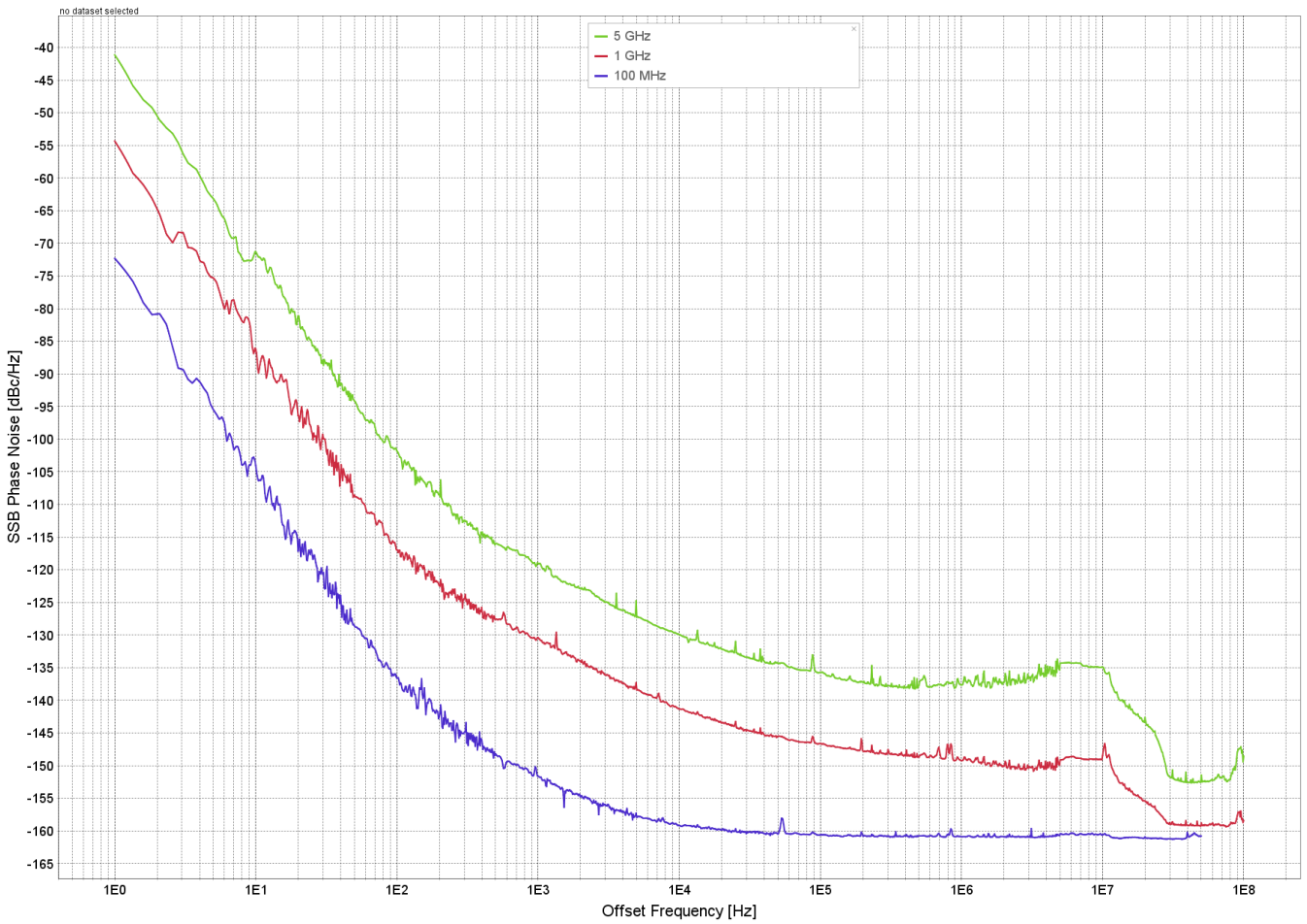
PARAMETER	MIN	TYPICAL	MAX	NOTE
Connector Type	MF1 OUT, MF2 OUT			see chapter CONNECTORS, IOS
Application	Pulse video, Marker signals			
Nominal output impedance	TBD			
Nominal output voltage	0 V		3.3 V	LVTTL

Fast Control Port (Option FCP)

PARAMETER	
Interface	Parallel bidirectional LVDS with 100 Ω termination at receiver
Common mode level	typ. 1.2V
Differential input threshold	typ. +/-100mV
Differential output voltage	typ. 300mV
Connector type	FCP IO, 36-pin mini-D female (3M MDR 102 Series)
Mode: IQ data stream	
Sampling rate (IQ samples)	125 MHz (optional 250 MHz)
Input/output format, interleaved clock	data (16 bits), clock signal, valid signal
Valid IQ data input to rf output delay at 125 MHz sample rate	typ. TBD ns
Mode: Segment ID streaming	
Input format	data (16 bits), valid signal (pin pair 18/36 signal must be static low or high)
Valid segment ID input to rf output delay (immediate segment changeover)	typ.TBD ns
Valid segment ID jitter	+/- 8 ns
Pin mapping	
Mode: Parameter setting	
Parameter	Frequency (up to 48bit), amplitude, phase
Input format	address (8 bits), data (8 bits), valid signal

TYPICAL PERFORMANCE CURVES

Figure 1: SSB Phase Noise Performance, CW without option LN, Pout = 10 dBm



Offset → RF ↓	1 Hz	10 Hz	100 Hz	1 kHz	10 kHz	100 kHz	1 MHz	floor
100 MHz		-119	-135	-148	-155	-156	-158	-159
1 GHz		-100	-114	-129	-140	-150	-152	-160
4 GHz		-87	-102	-118	-129	-139	-140	-151

Figure 2: SSB Phase Noise Performance, CW with option LN, 1 GHz, Pout = 10 dBm

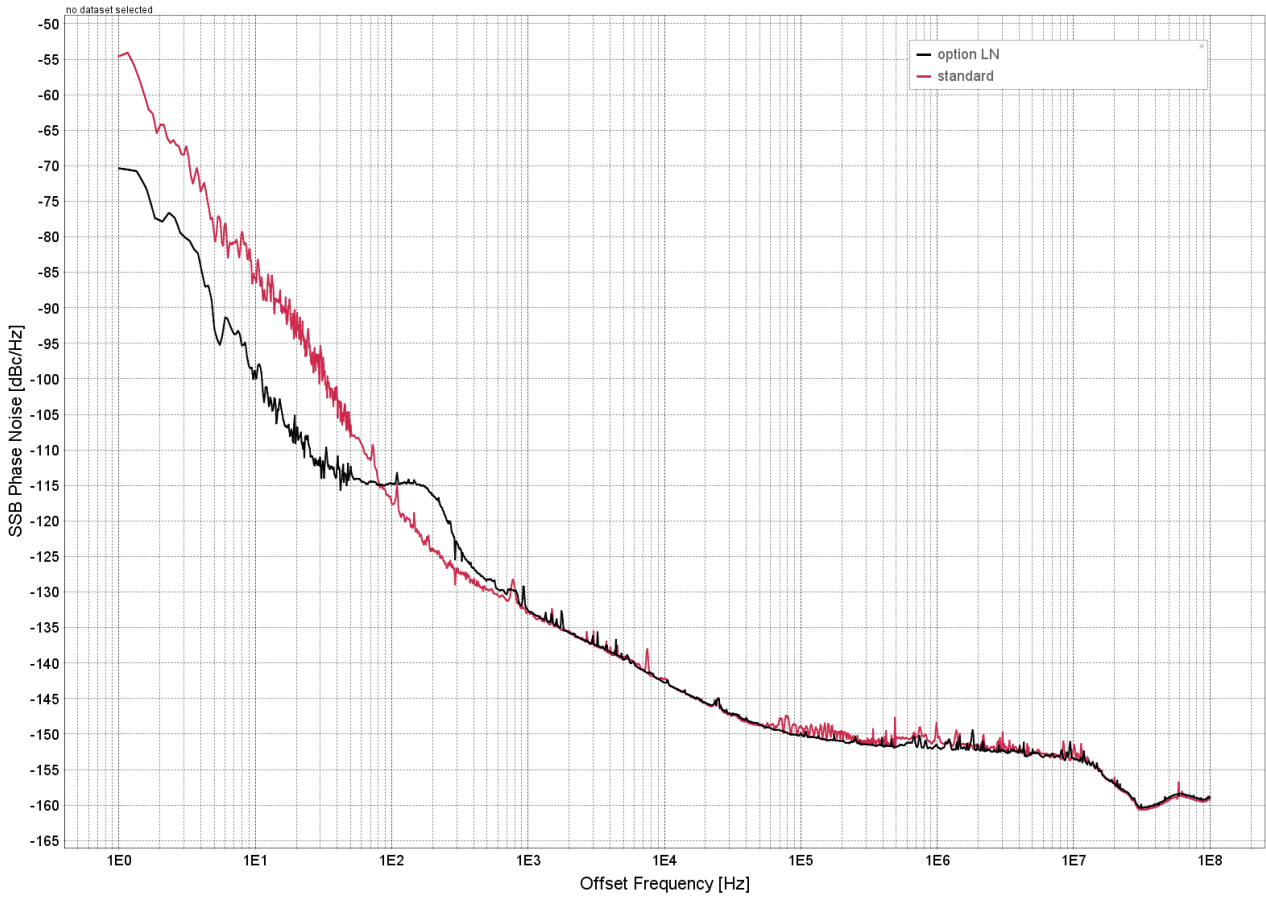


Figure 2a : Amplitude Noise, 2 GHz, Pout = 10 dBm

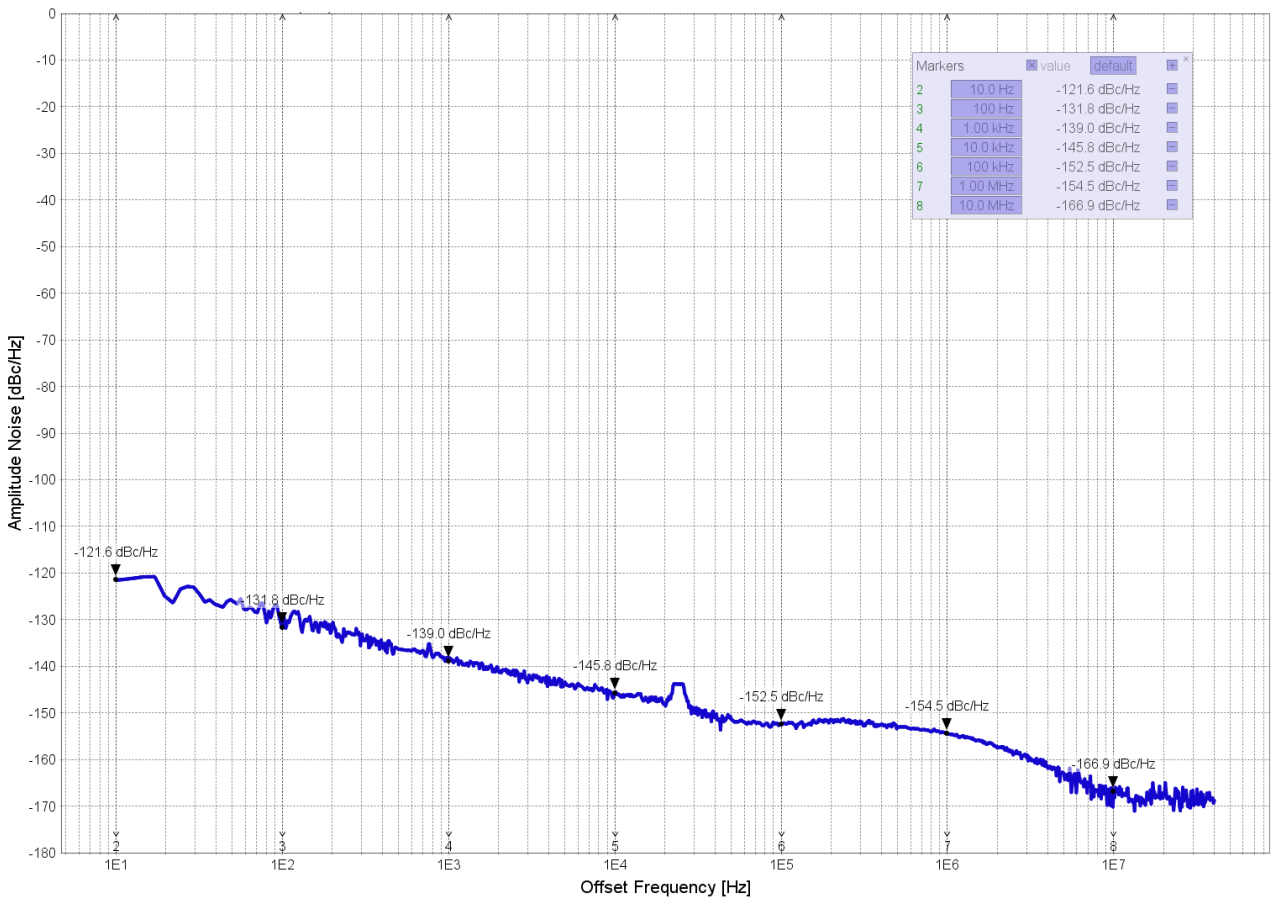


Figure 3: Maximum Output Power

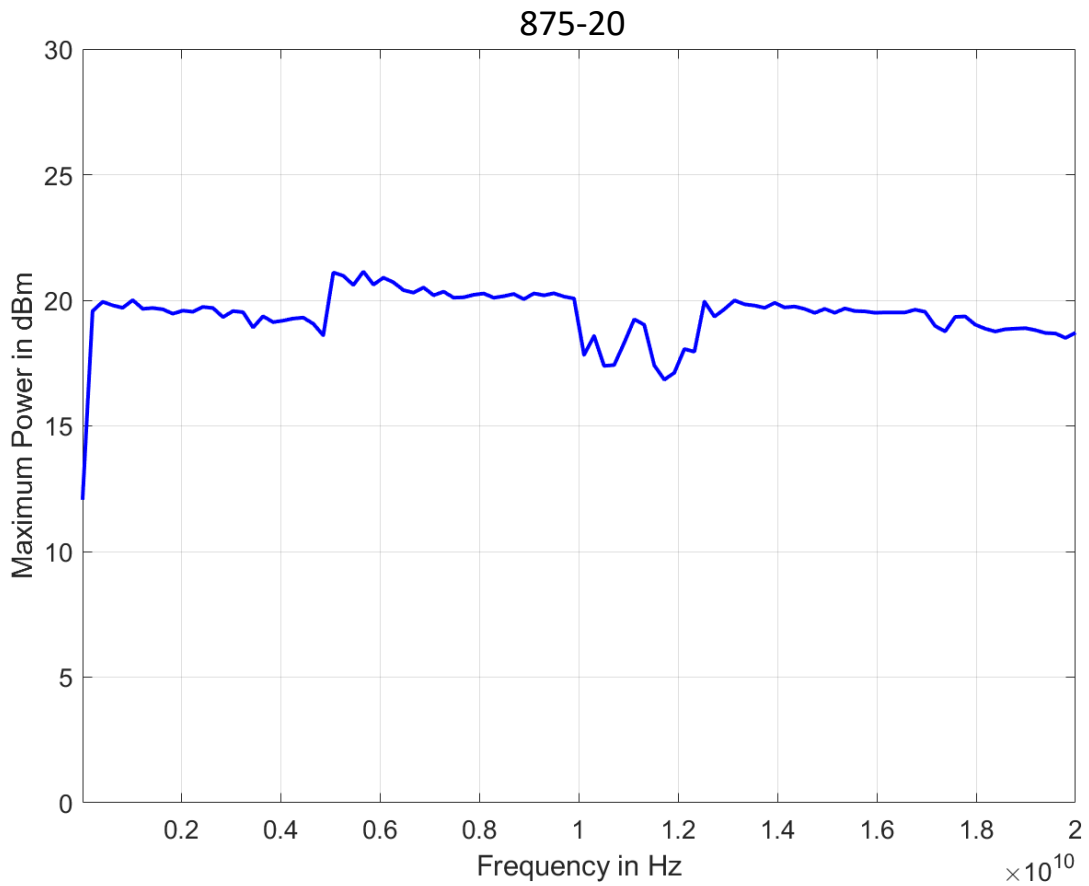
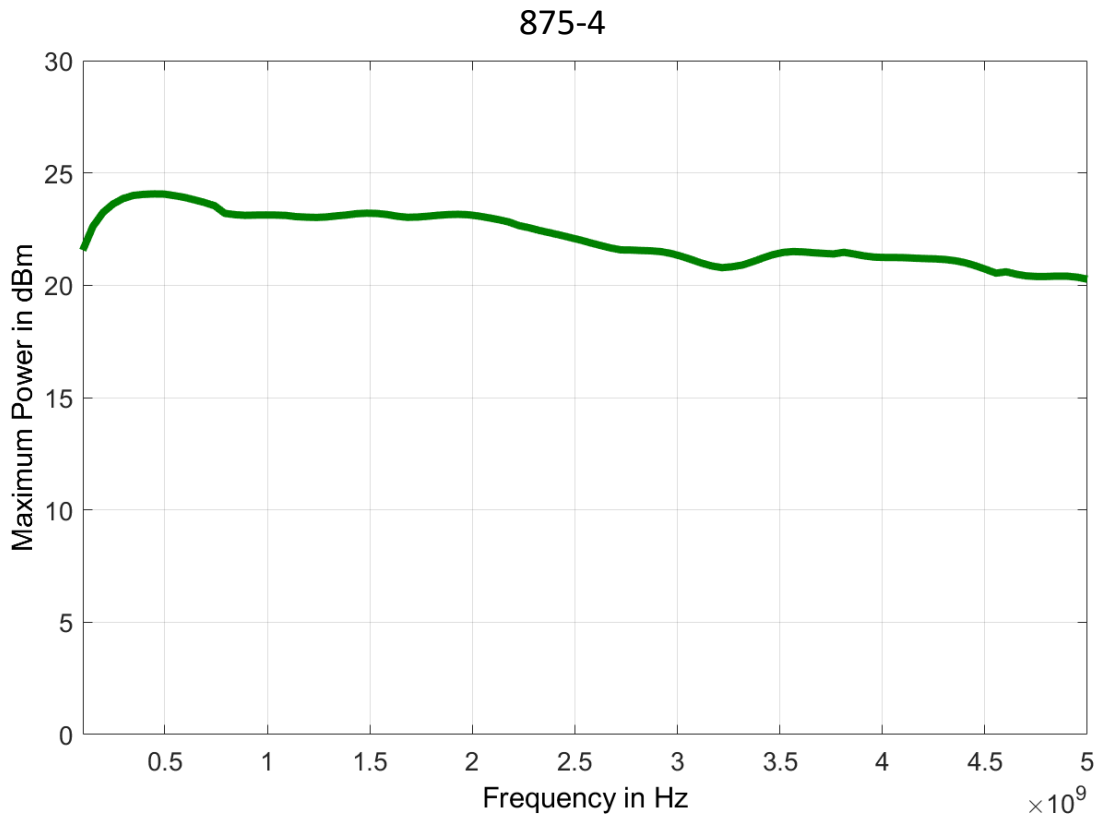


Figure 4: Harmonic performance at 0 dBm

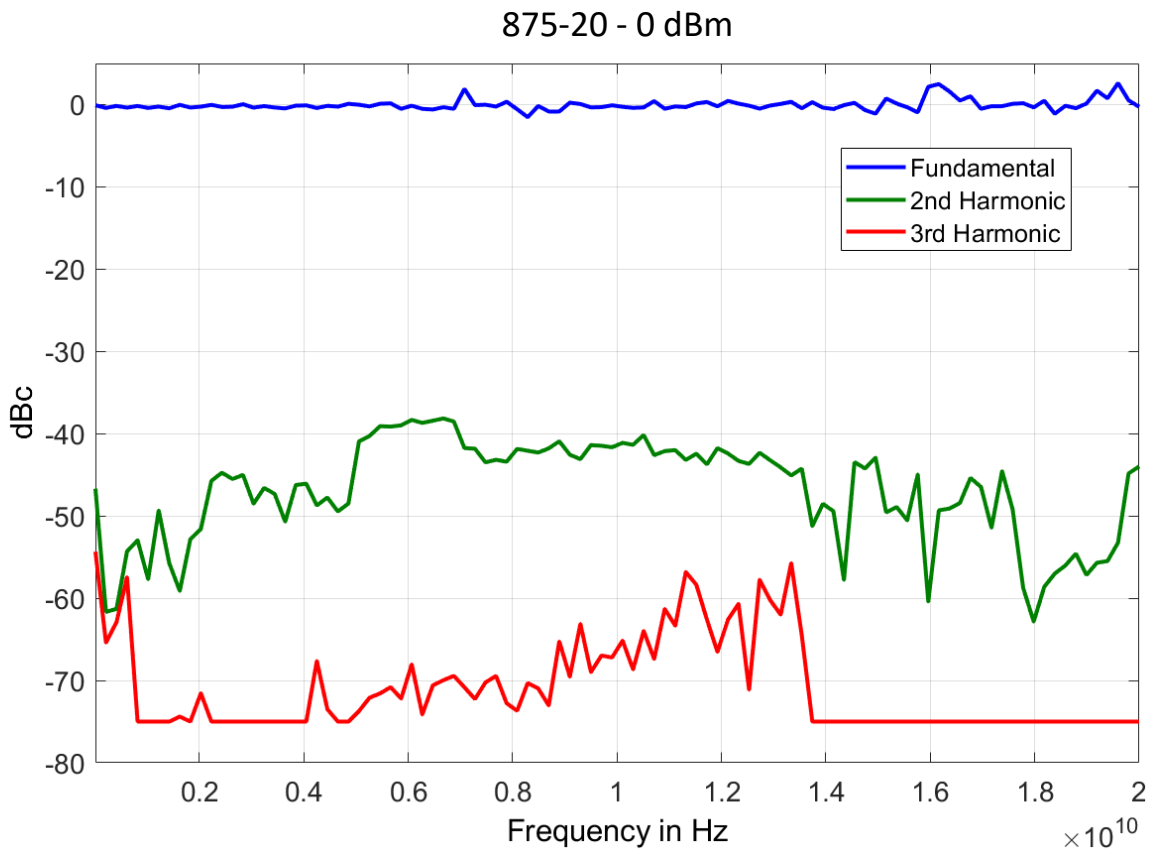
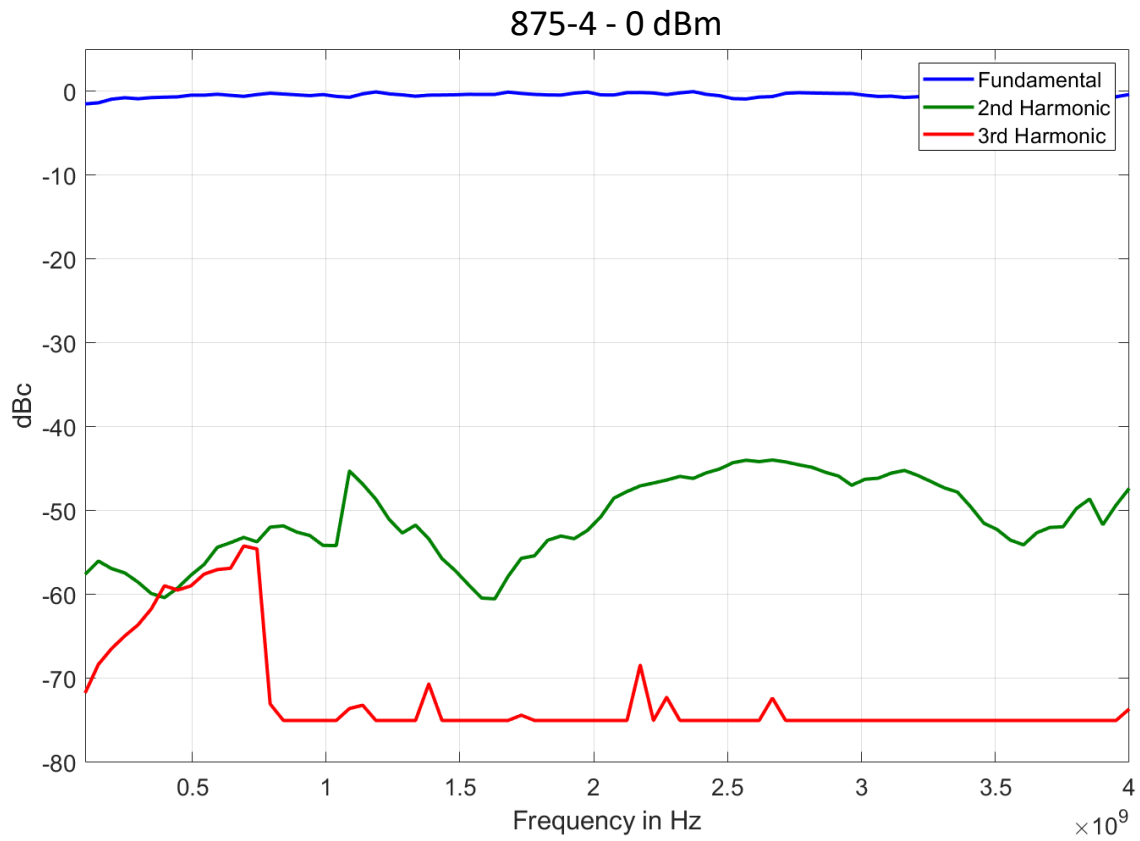
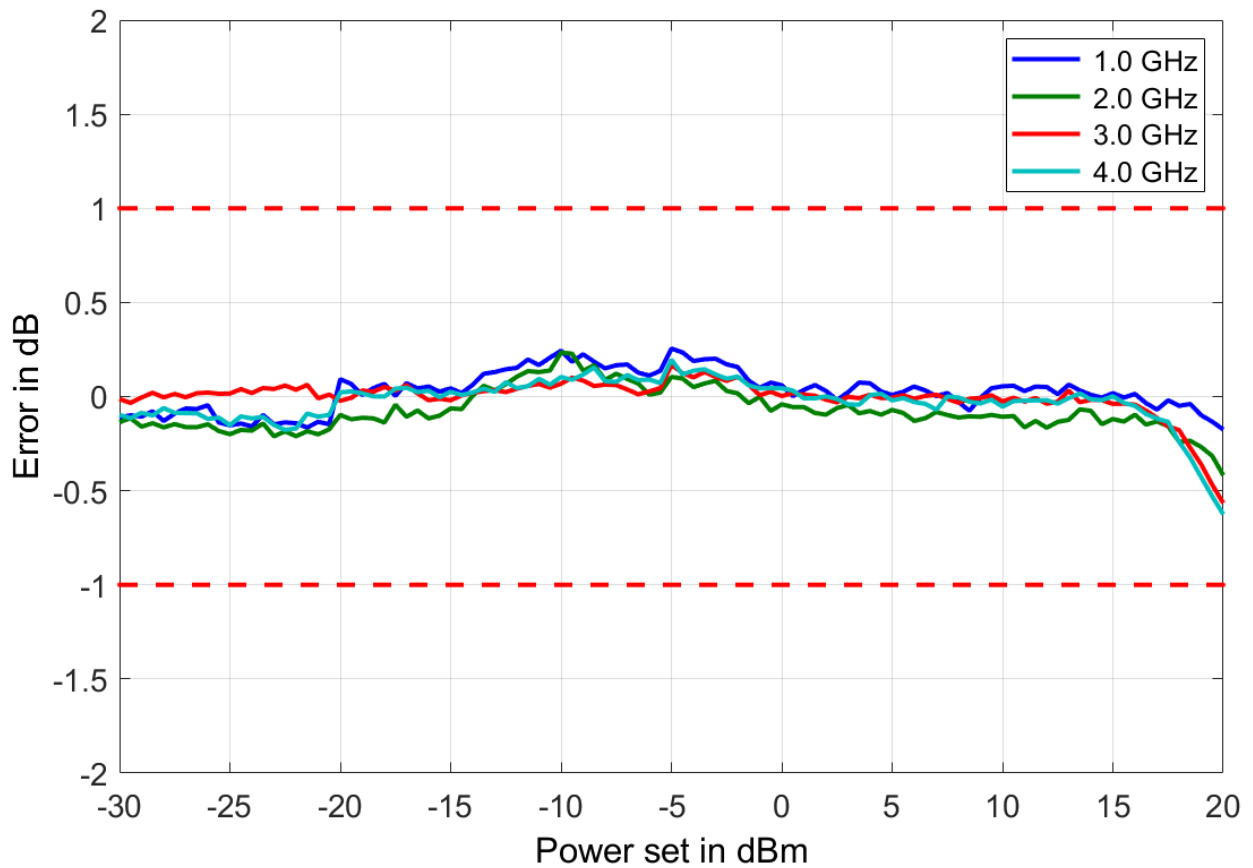
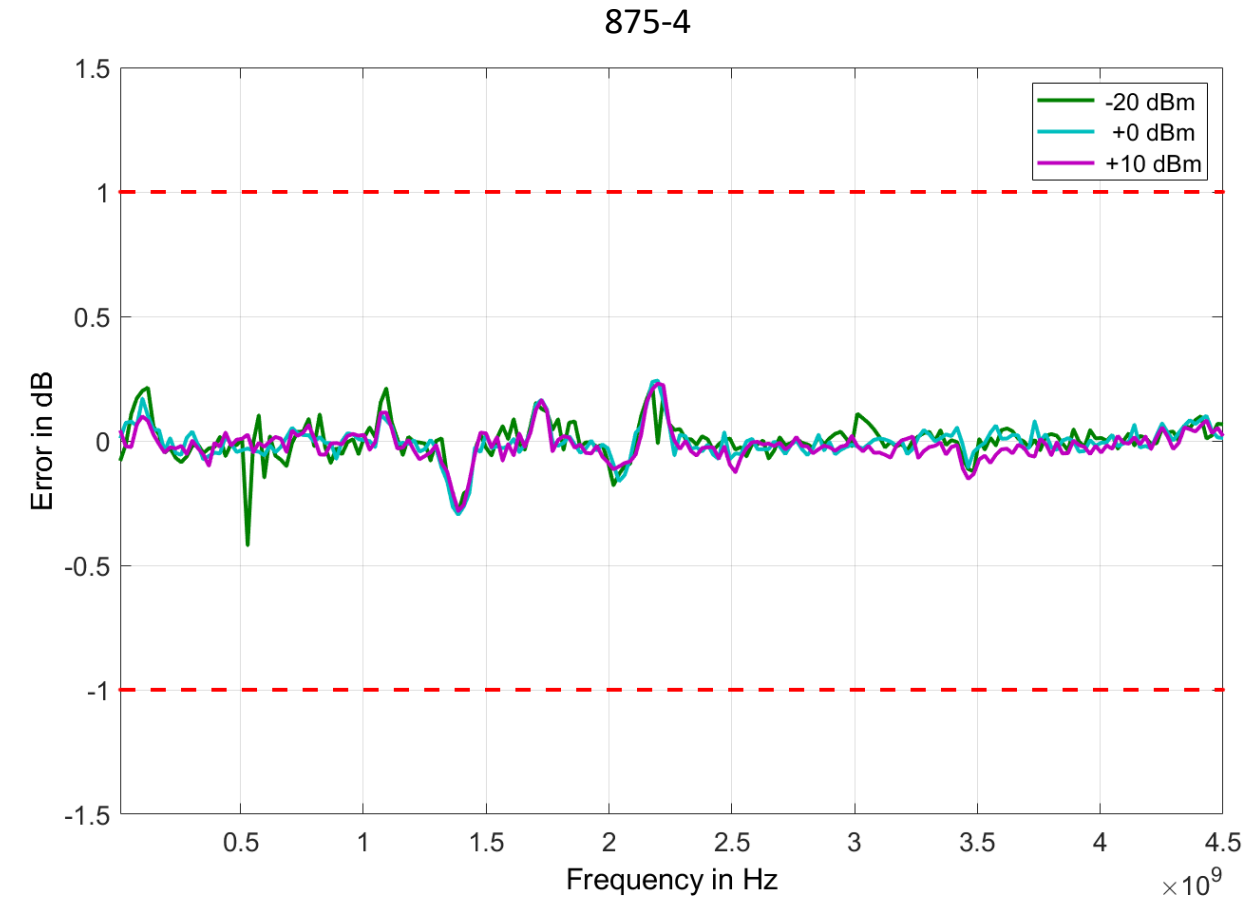
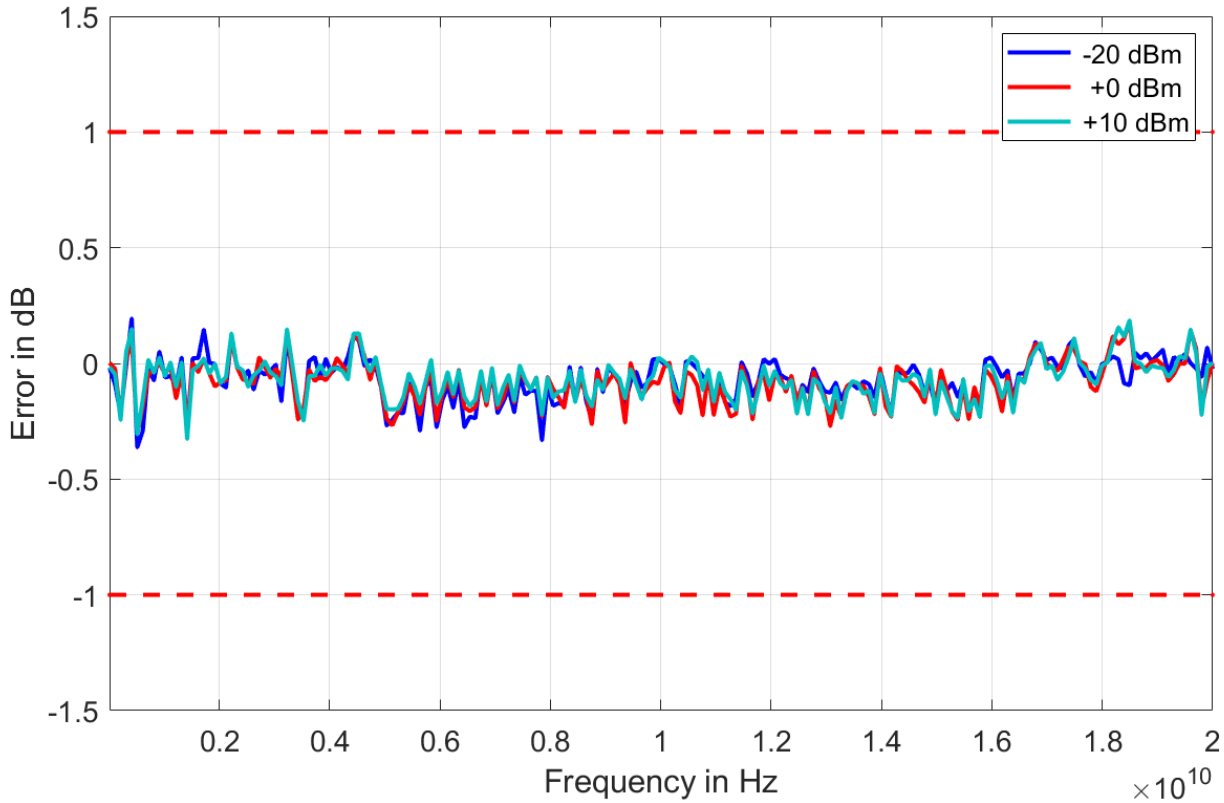


Figure 5: Level accuracy



875-20



875-20

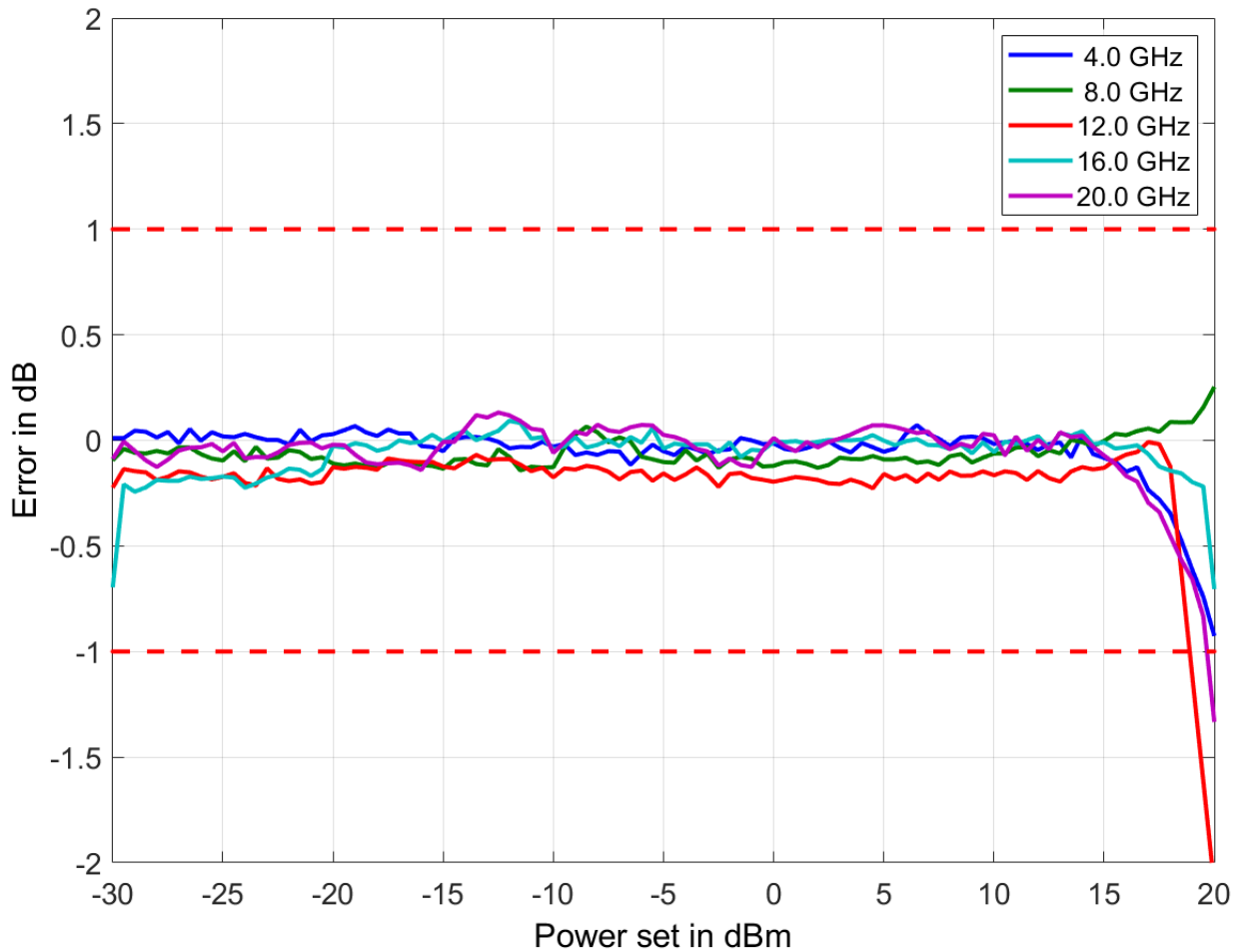


Figure 6: IQ Relative Response (measured)

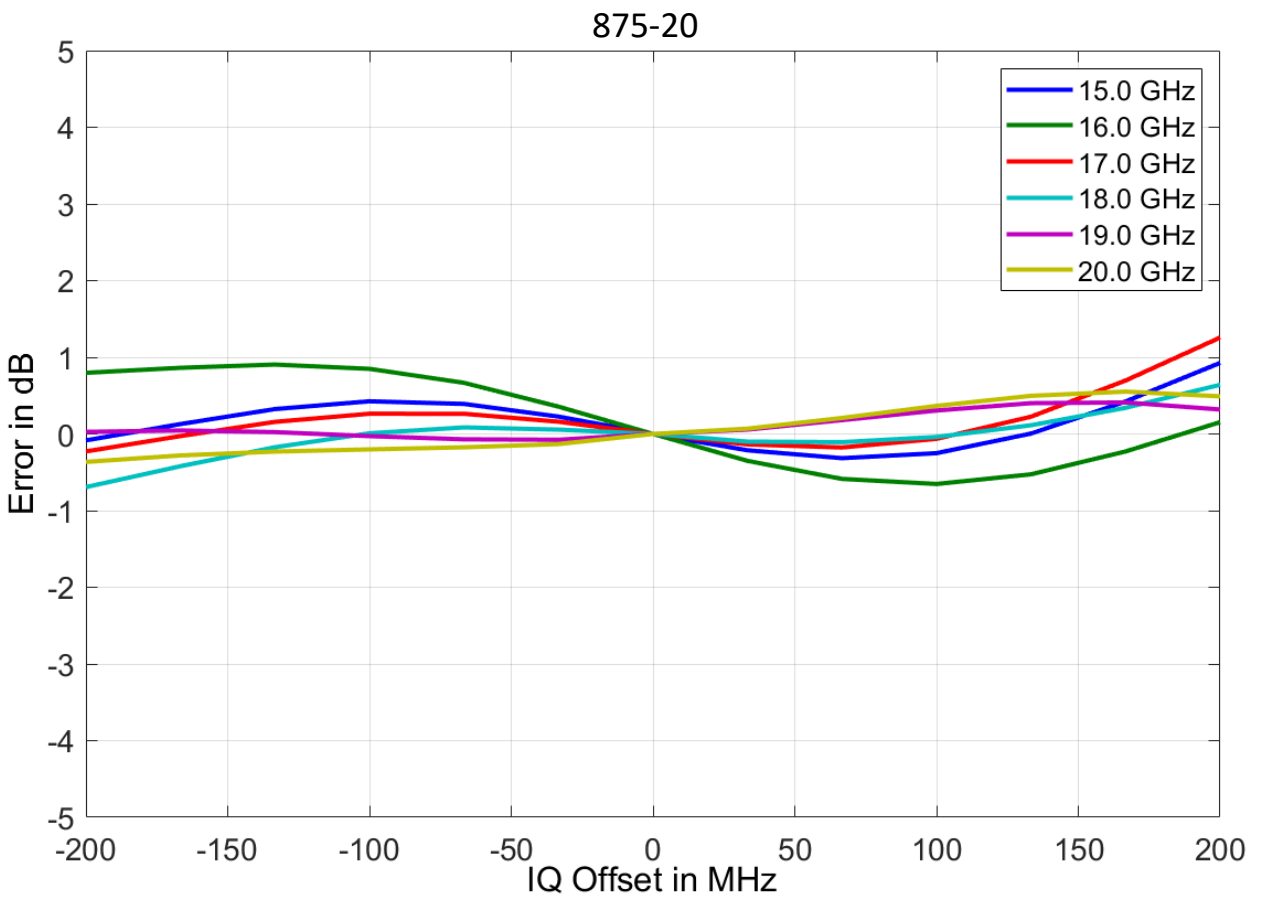
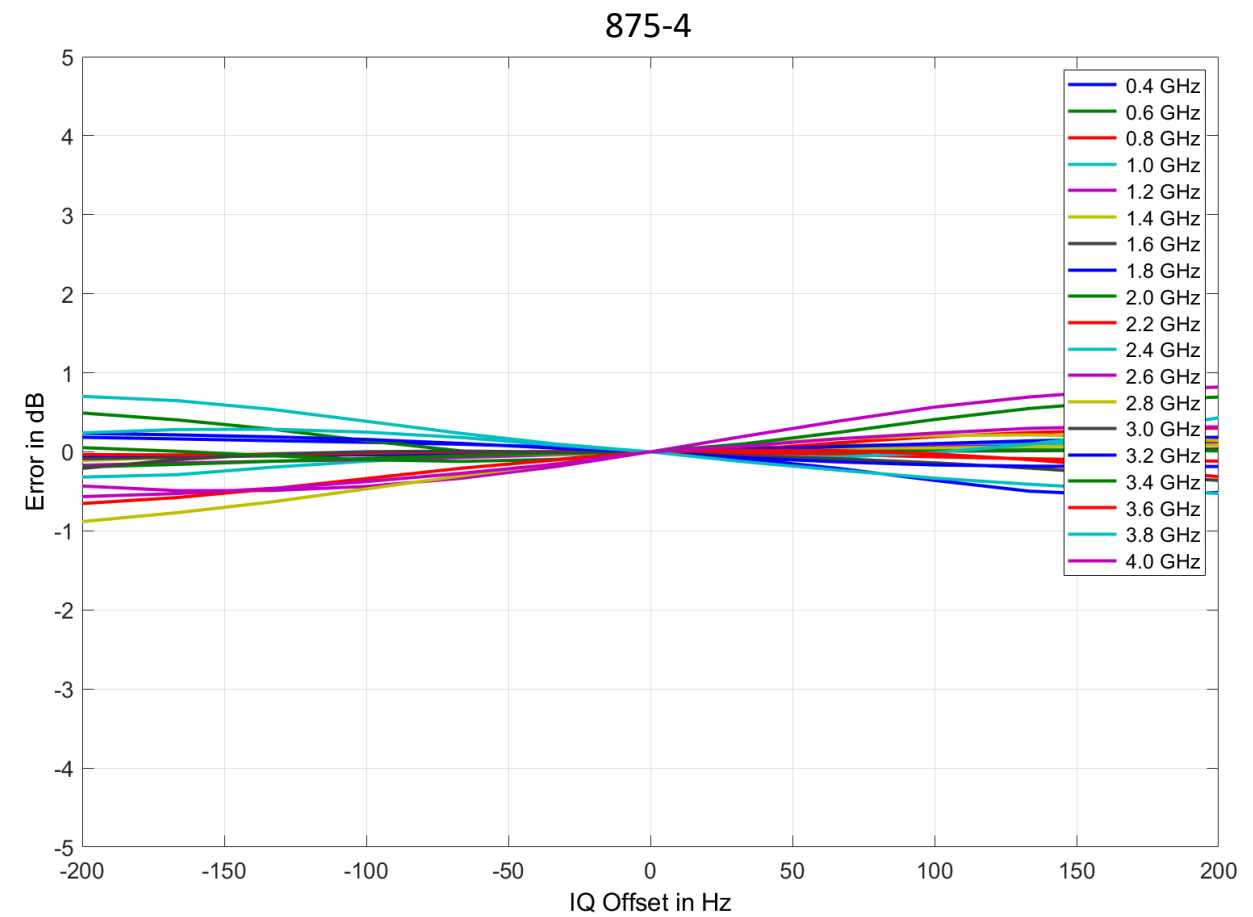


Figure 7: 64-tone 400 MHz bandwidth signal

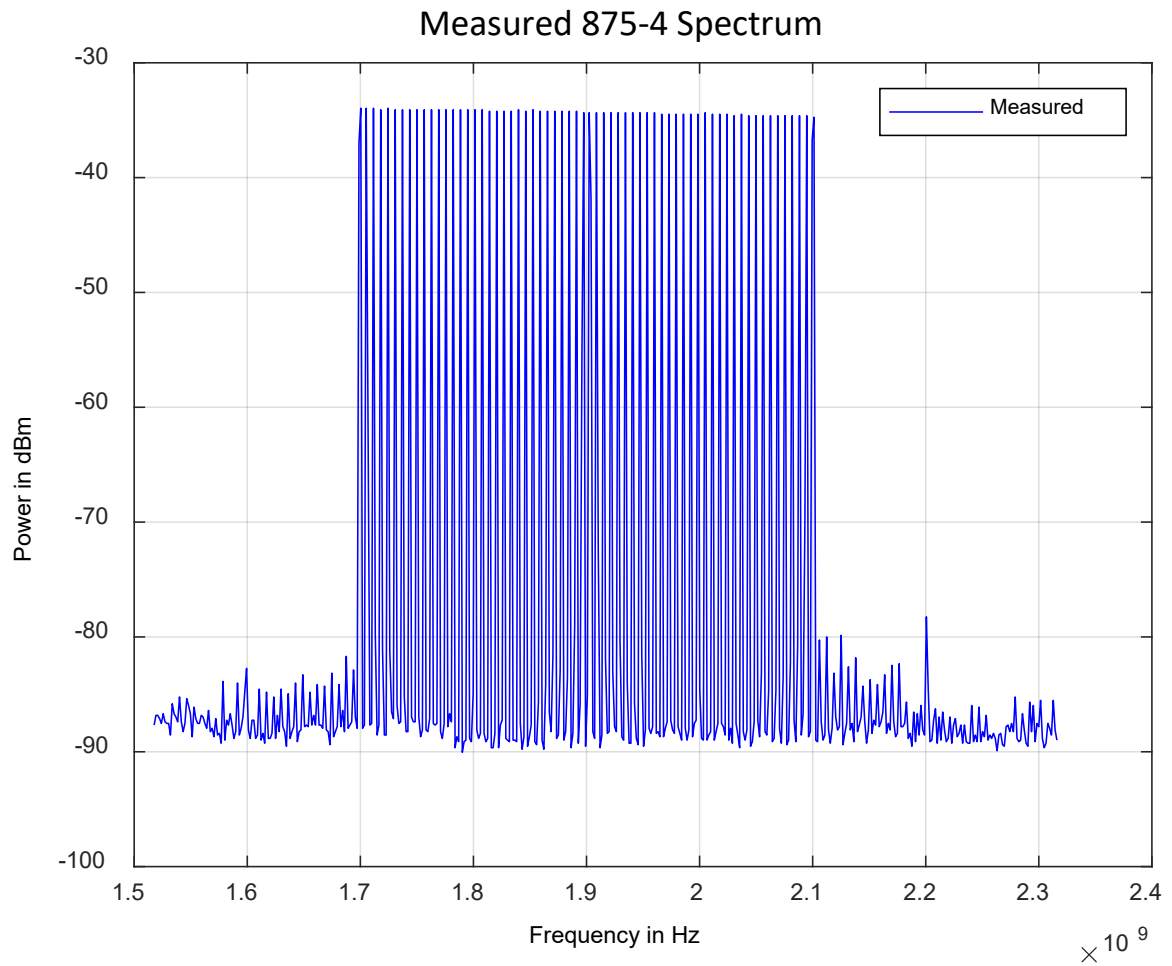


Figure 8: Two-tone sideband rejection

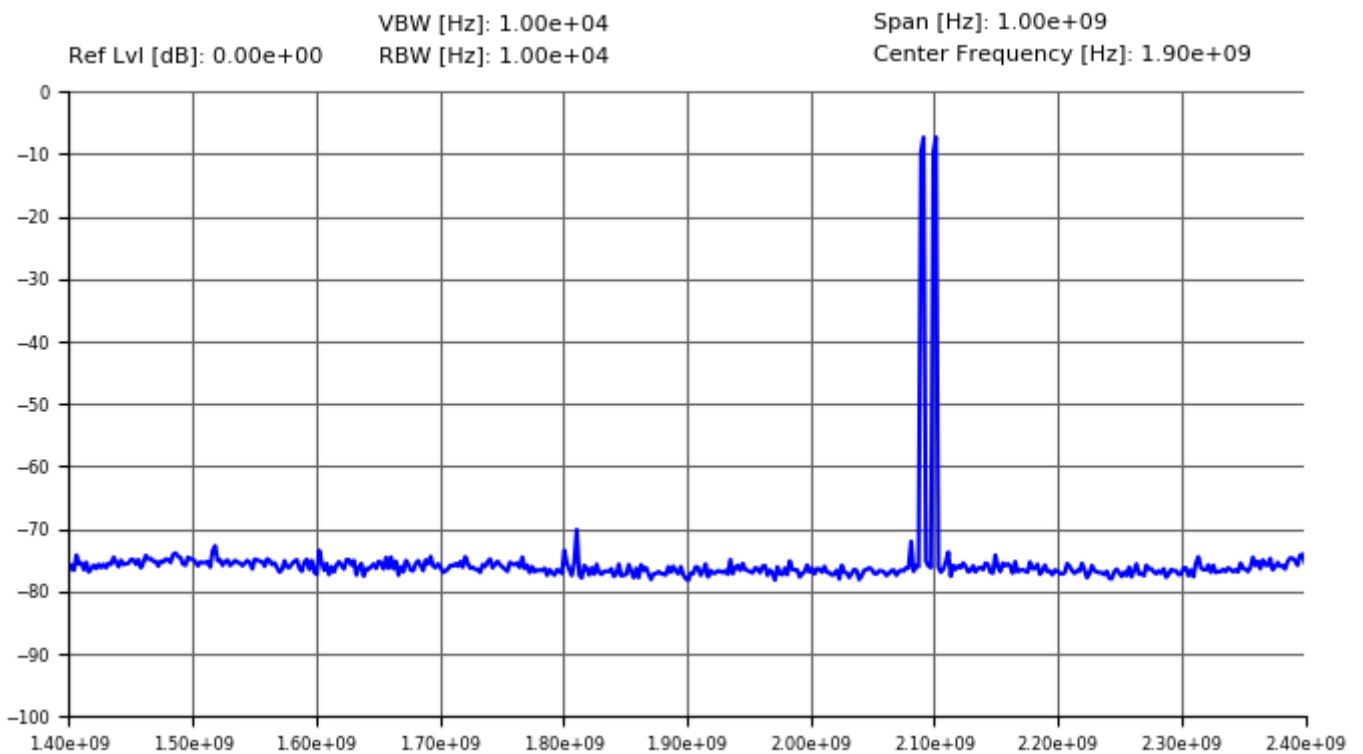


Figure 9: Wideband FM (1MHz rate, 200 MHz deviation)

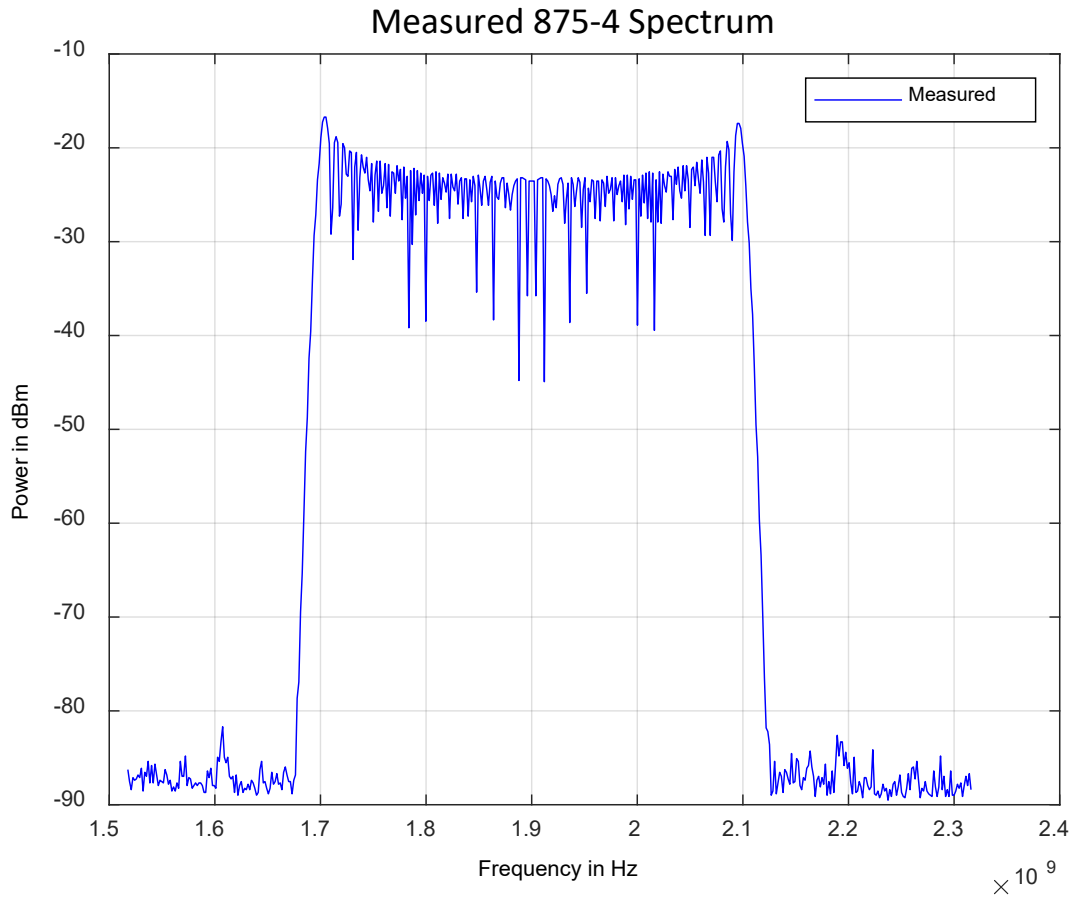


Figure 10: Pulsed chirp (10 microseconds, 400 bandwidth)

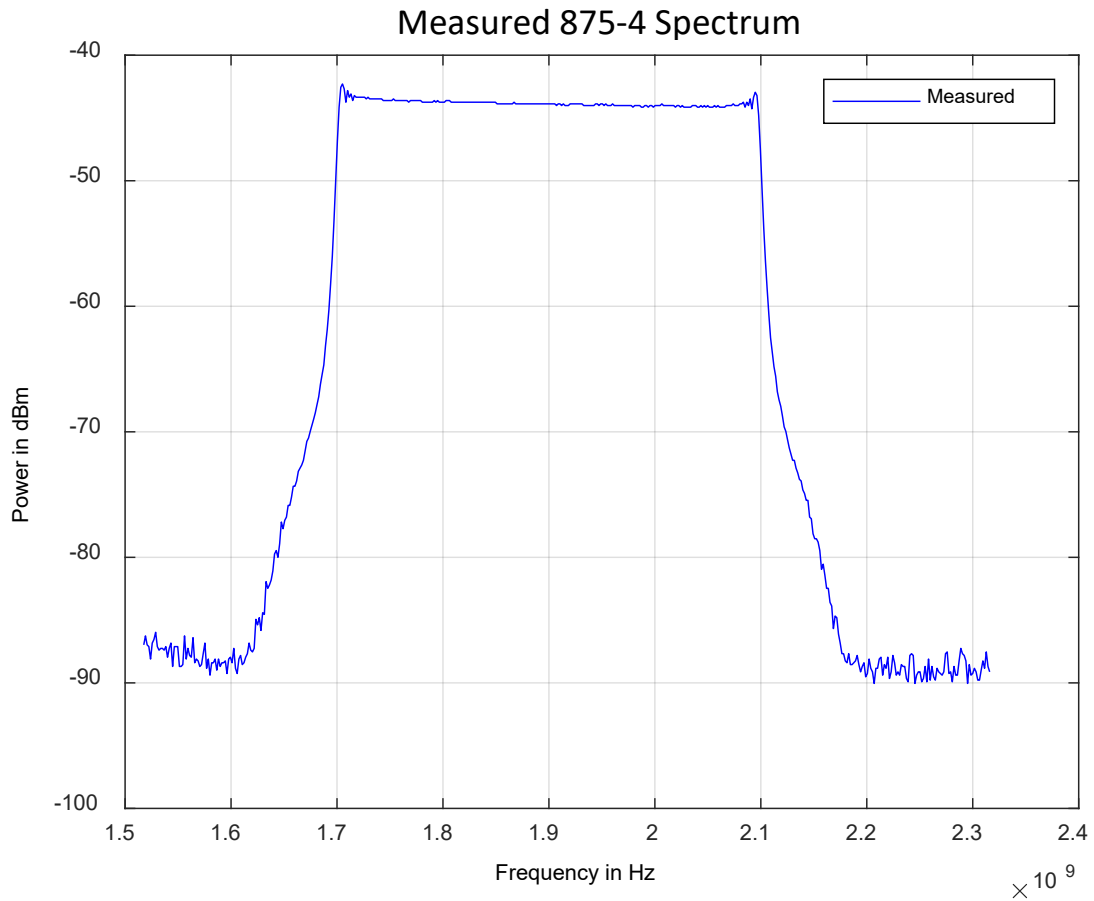


Figure 11: Amplitude modulation (1 kHz rate, 80% depth)

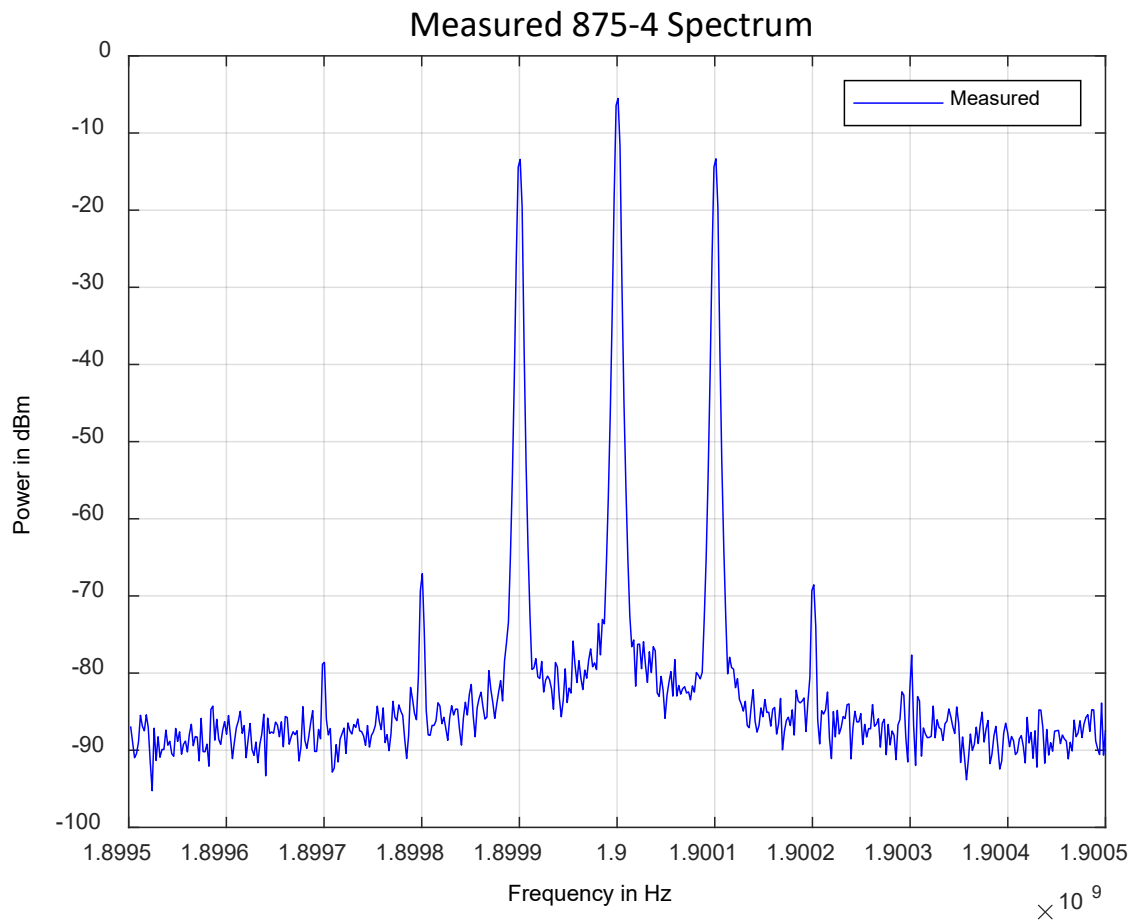


Figure 12: DME Spectrum (X channel, raised cosine filter)

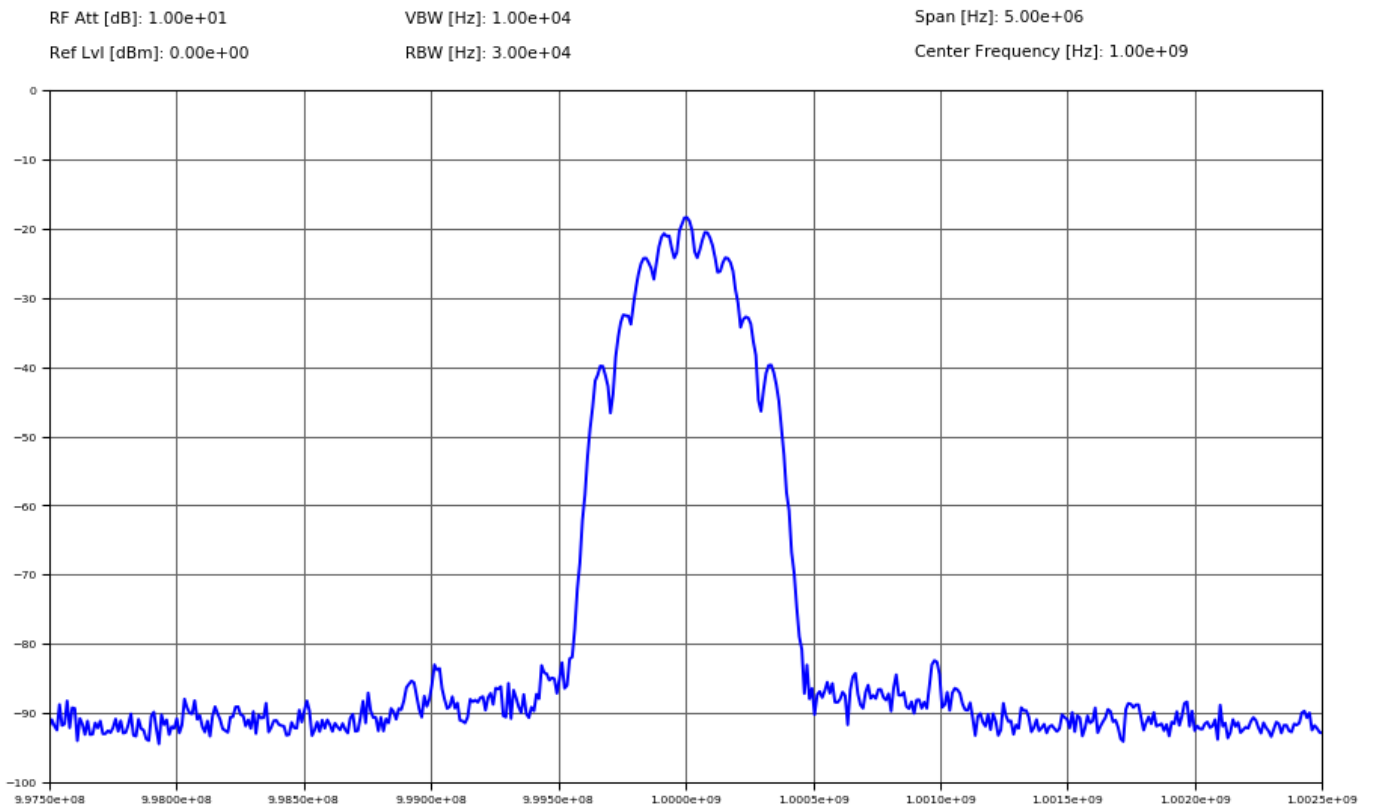


Figure 13: Pulse modulation (10 MHz rate, 10 ns pulse width)

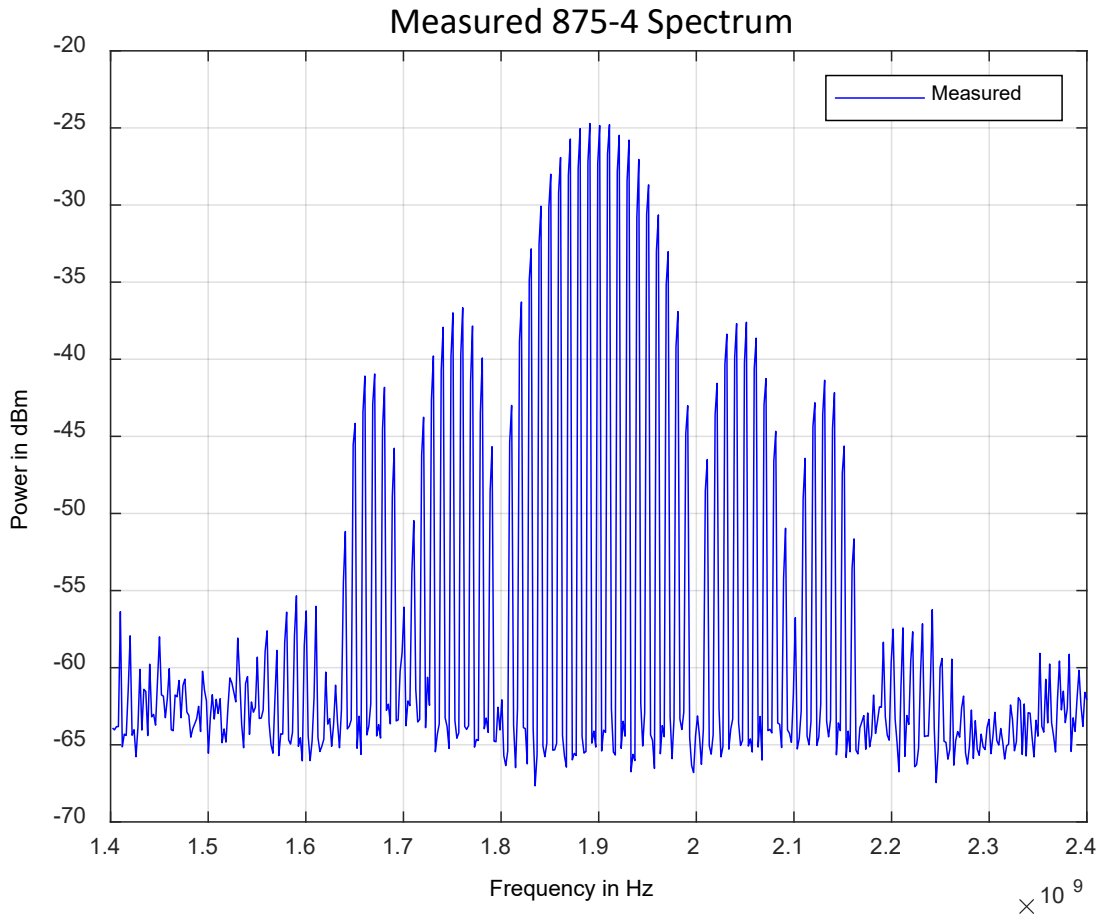


Figure 14: 256QAM 10 MS/s

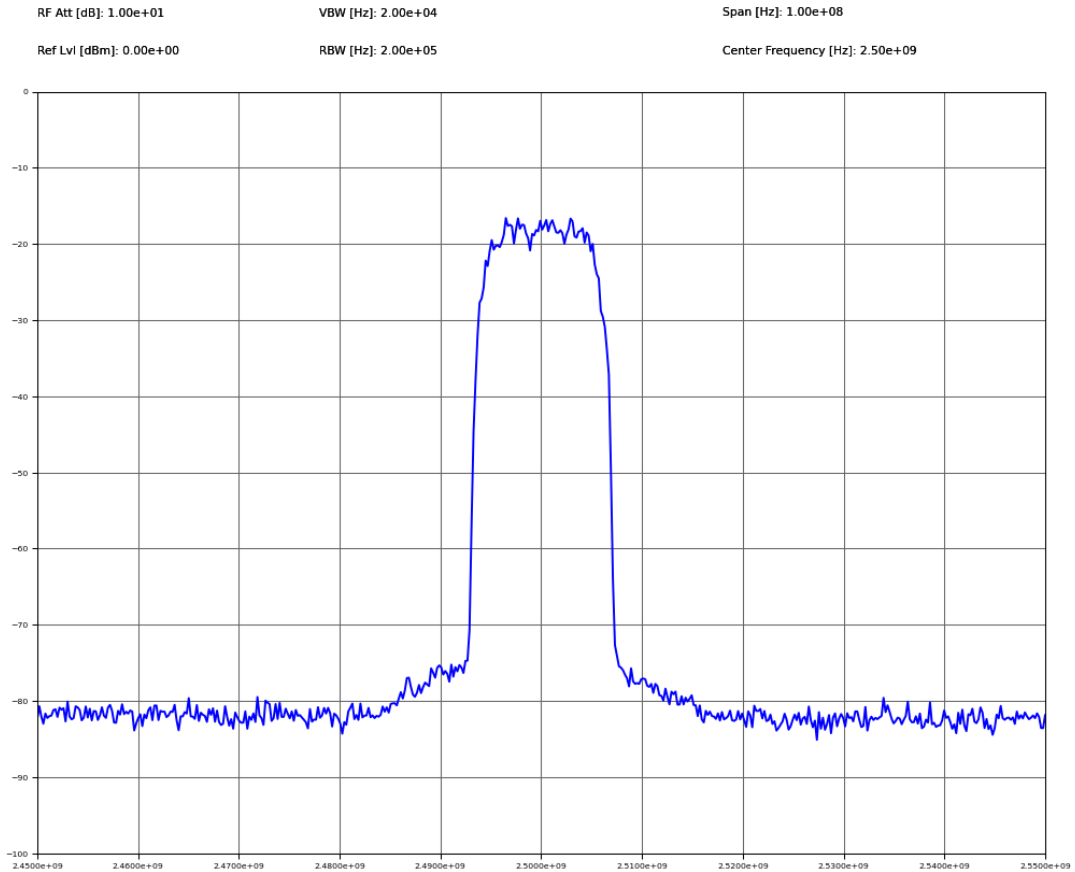


Figure 15: 16QAM 250 MS/s

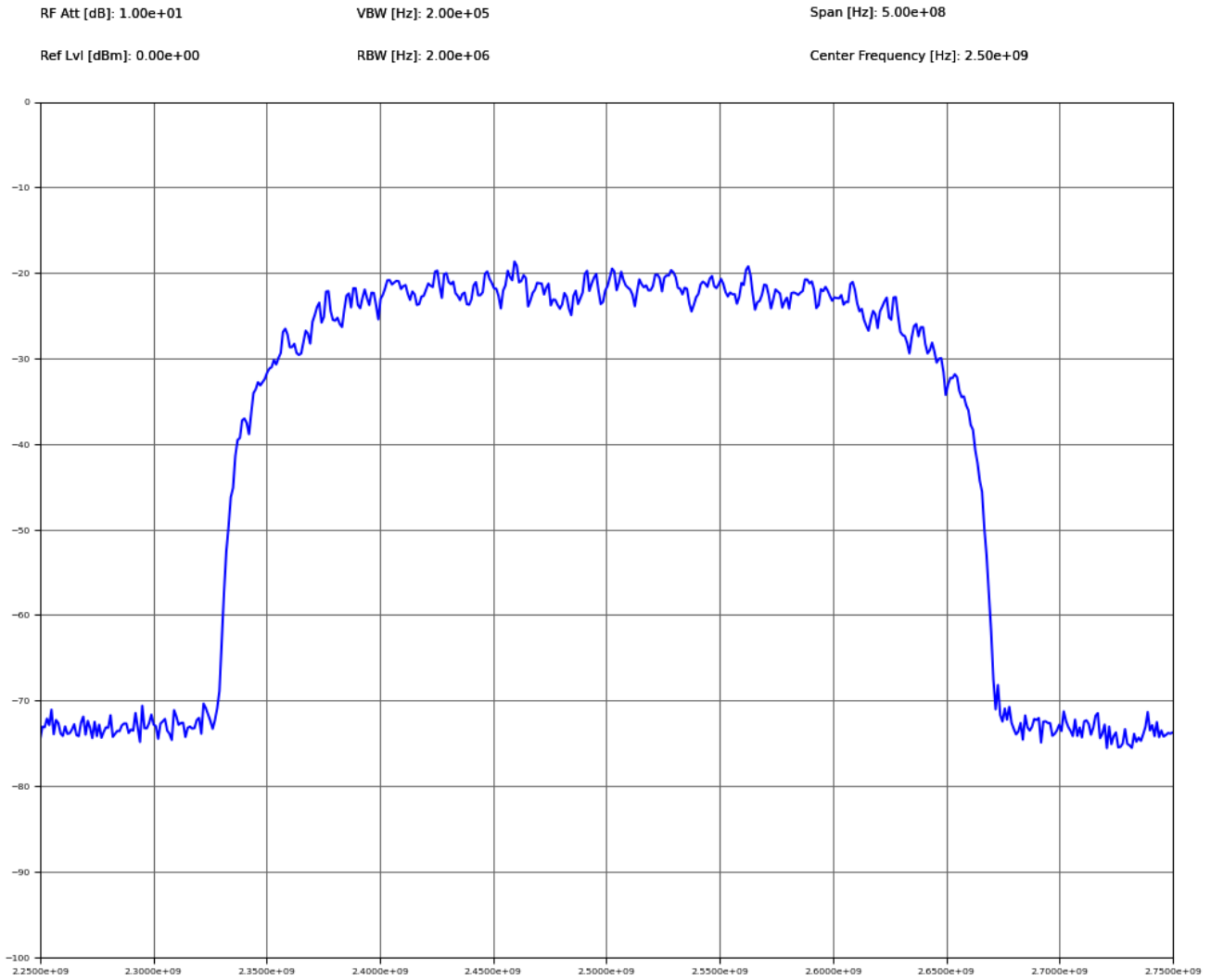


Figure 16: EMV vs Output Power, 16QAM, 10 MS/s, 2.5 GHz

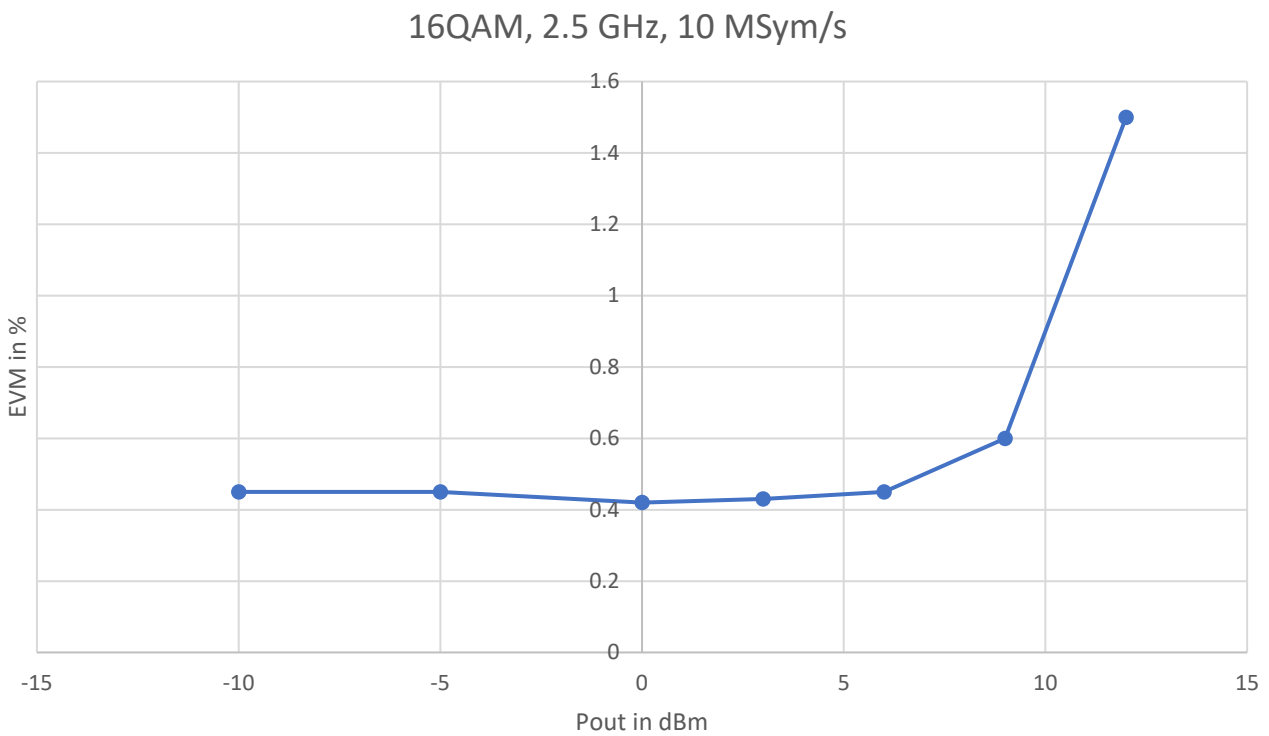


Figure 17: EMV vs Symbol Rate, 16QAM

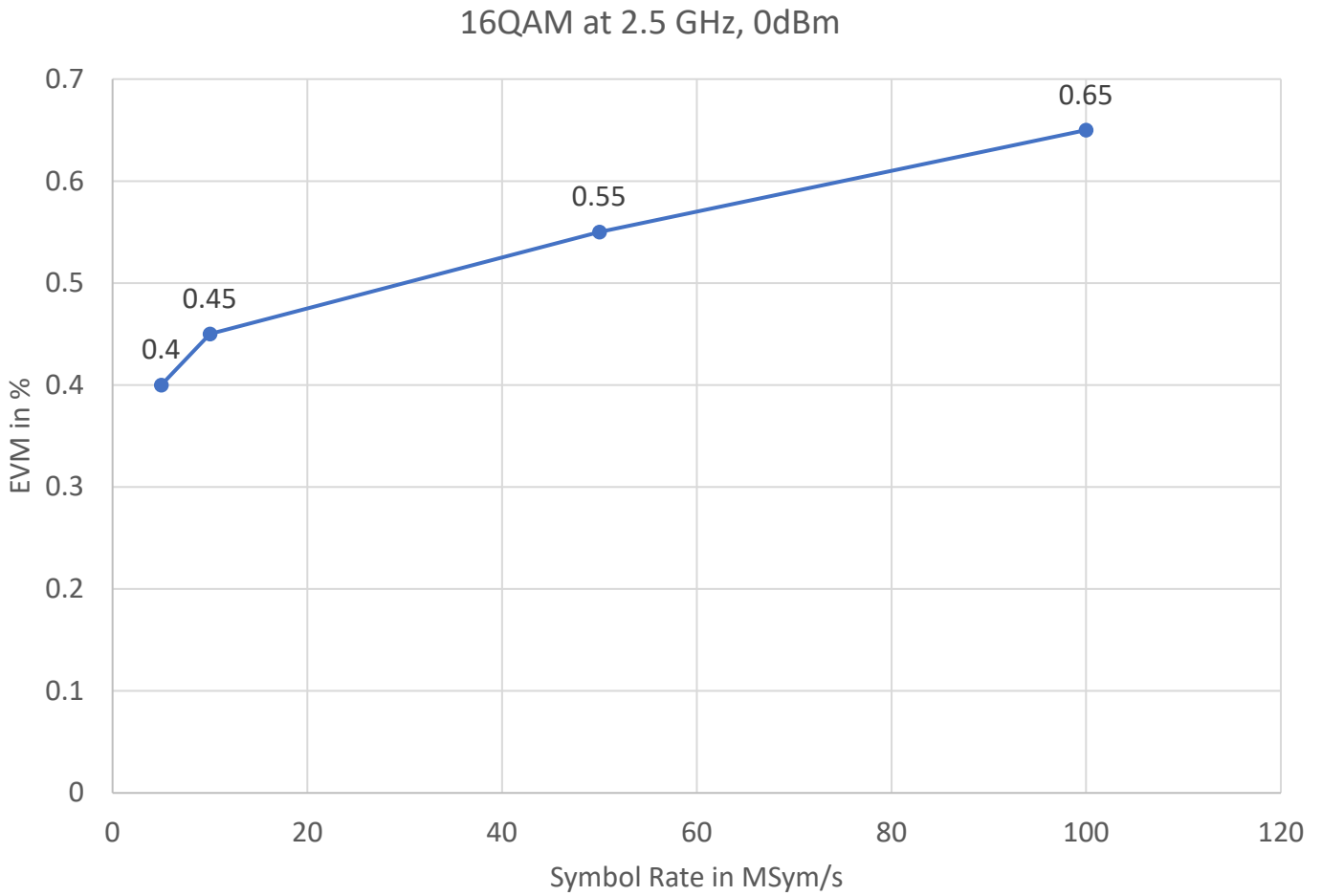


Figure 18: EMV vs RF Frequency, 16QAM, 10 Msymbols/s

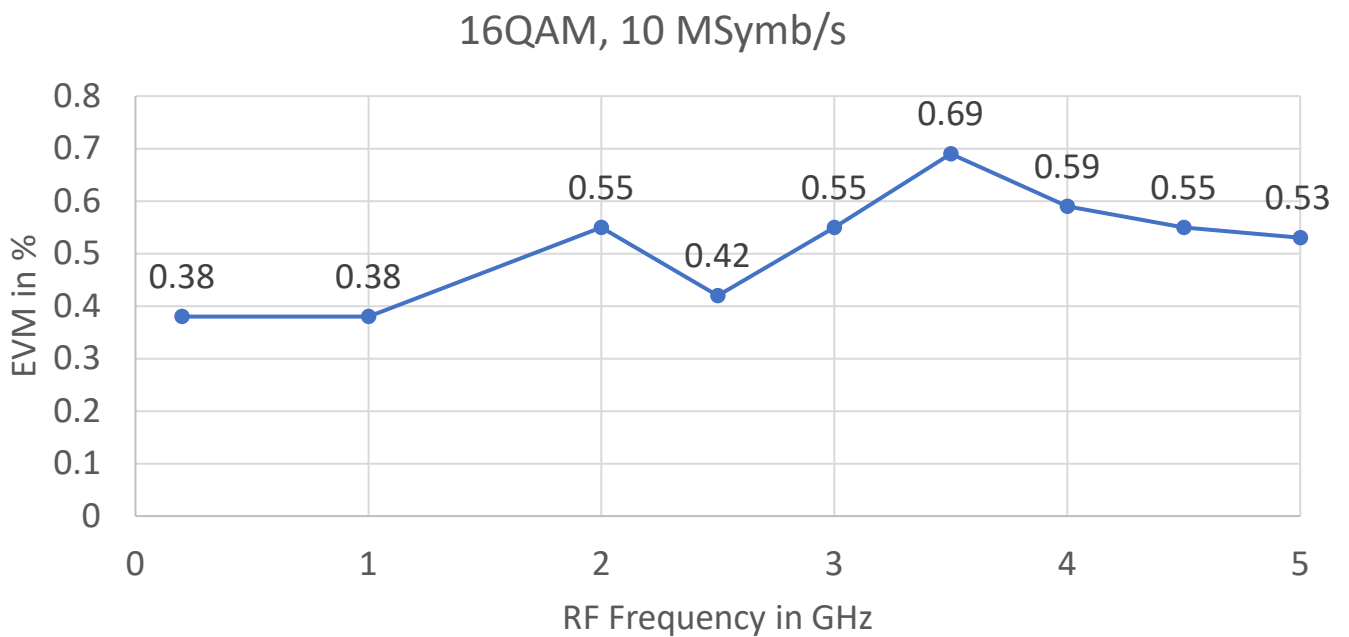


Figure 19: Typical VSWR (875-4)

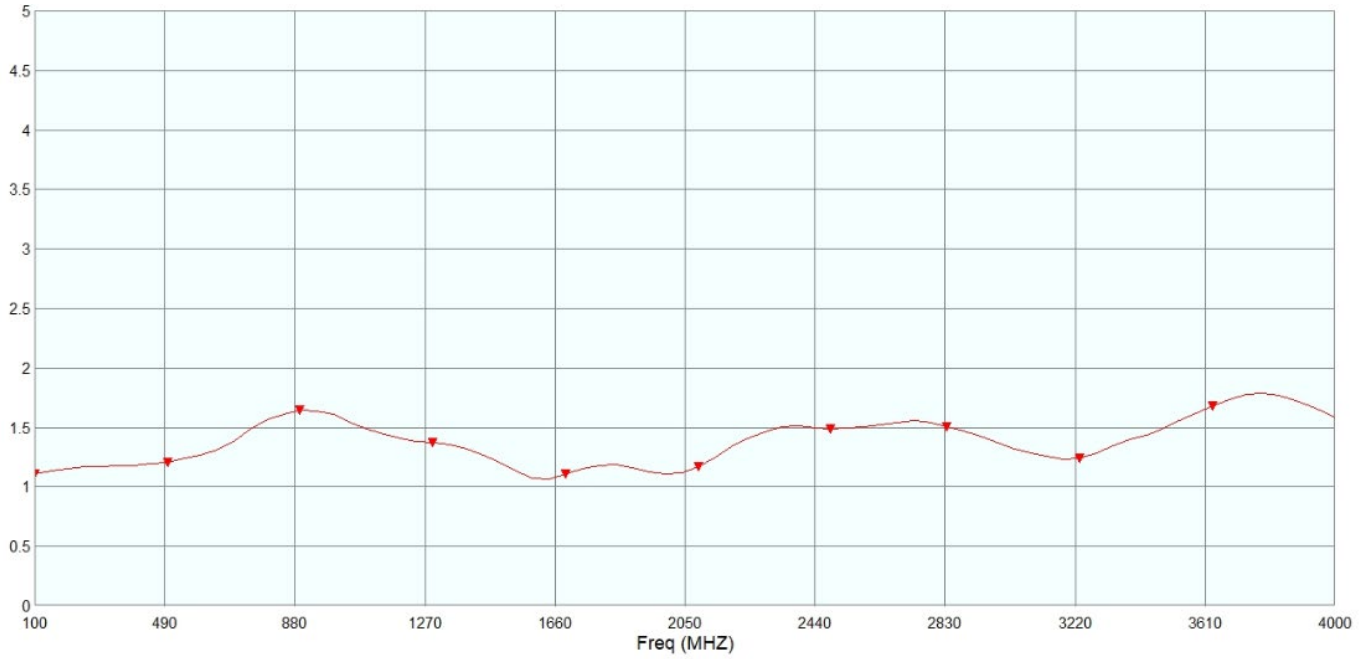
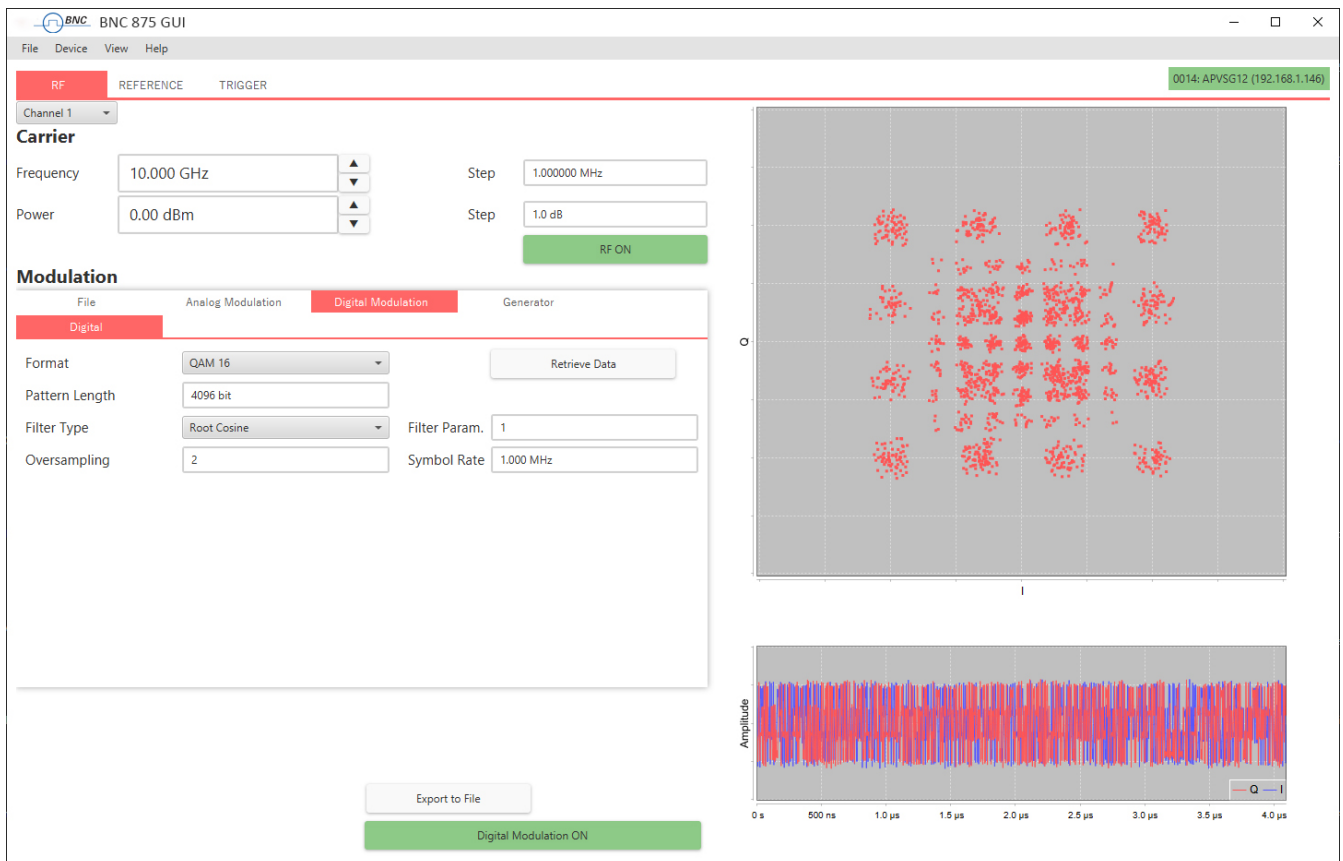


Figure 20: Typical VSWR (875-12 & 875-20)

tba

Figure 21: User Interface



CONNECTORS, IOS

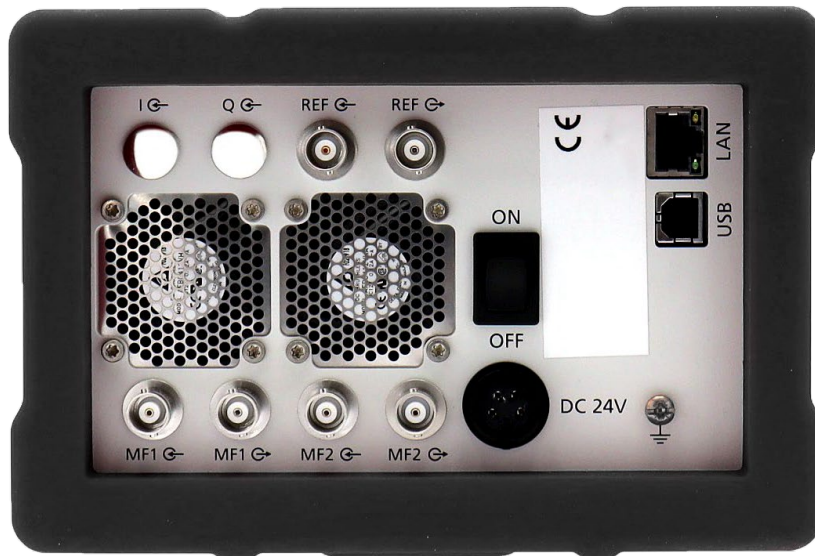
Front panel (single channel model):

LABEL	TYPE	DESCRIPTION	OPTION
RF 50 Ω	N female (875-4/875-6/875-12) SMA female (875-20) K (2.92mm) female (875-40)	RF output	



Rear panel (single channel model):

LABEL	TYPE	DESCRIPTION	OPTION
I & Q IN	BNC female	Input for analogue in-phase signals	AIQ
REF IN, REF OUT	BNC female	Reference frequency input & output	
USB	USB type B	Remote programming interface	
LAN	RJ-45	Remote programming interface	
DC24V	DC power plug female	Power of Instrument	
MF1 IN, MF2 IN	BNC female	Multi-function inputs: user-configurable (e.g. trigger, external pulse)	
MF1 OUT, MF2 OUT	BNC female	Multi-function outputs: user-configurable (e.g. trigger, marker)	
ON/OFF	SWITCH	Turns the device on or off.	
GROUND SCREW		Connects the device to ground reference	



Front panel (2U multi (2 to 4) channel model):

LABEL	TYPE	DESCRIPTION	OPTION
RF OUT (for each channel)	SMA female / K (2.92mm) female (875-40-X)	RF output	



Rear panel (2U multi (2 to 4) channel model):

LABEL	TYPE	DESCRIPTION	OPTION
USB	USB type B	Remote programming interface	
LAN	RJ-45	Remote programming interface	
GPIB	24-pin female	Remote programming interface	GPIB
REF IN	SMB female	Reference frequency input	
REF OUT	SMB female	Reference frequency output	
CLK IN	SMB female	High-stability reference input	
CLK OUT	SMB female	High-stability reference output	
FCP (for each channel)	36-pin mini-D female	Fast control port	FCP
MF1 IN, MF2 IN (for each channel)	SMB female	Multi-function inputs: user-configurable (e.g. trigger, external pulse)	
MF1 OUT, MF2 OUT (for each channel)	SMB female	Multi-function outputs: user-configurable (e.g. trigger, marker)	
I IN, Q IN (for each channel)	SMB female	Analog IQ-modulation inputs	AIQ



ORDERING INFORMATION



HOST MODEL	PRODUCT	DESCRIPTION
875	875-4	4 GHz model
875	875-6	6 GHz model
875	875-12	12 GHz model
875	875-20	20 GHz model
875	875-40	40 GHz model
875-4-X	875-4-X	4 GHz model (X channels)
875-6-X	875-6-X	6 GHz model (X channels)
875-12-X	875-12-X	12 GHz model (X channels)
875-20-X	875-20-X	20 GHz model (X channels)
875-40-X	875-40-X	40 GHz model (X channels)
875(-X)	Option LN	Enhanced close-in phase noise & frequency stability
875(-X)	Option UFS	Ultra-fast switching speed
875(-X)	Option FCP	Fast control port (digital IQ data streaming)
875(-X)	Option MOD	Analog modulations
875(-X)	Option IVM	Internal vector modulations
875(-X)	Option AVIO	Avionic modulations
875(-X)	Option VREF	Variable REF input
875(-X)	Option AIQ	External analog I/Q Inputs

GENERAL CHARACTERISTICS

Remote programming interfaces

- Ethernet 100BaseT LAN interface,
- USB 2.0 device interface
- GPIB (IEEE-488.2,1987) with listen and talk (Option GPIB)
- Control language SCPI Version 1999.0

Power requirements

Single channel model

Input voltage range	24 VDC \pm 3.0 V	
Power consumption (typ) (without options)	45W	875-4
	55W	875-6, 875-12
	65W	875-20, 875-40
Main adapter supplied (without options)	100 - 240 VAC 50/60Hz; 24 VDC and 65W max	875-4, 875-6, 875-12
	100 - 240 VAC 50/60Hz; 24 VDC and 160 W max	875-20, 875-40

Multi-channel model

Input voltage range	100 - 240 VAC 50/60Hz	
Fuse rating	5x20mm, 250 V, 5 AT	2-poles, each
Power consumption (max) (without options)	200 W	875-4-4

Environmental (Levels similar to MIL-PRF-28800F Class 3/4)

Environmental stress Samples of this product have been type tested to be robust against the environmental stresses of storage, transportation, and end-use; those stresses to temperature, humidity, shock, vibration, altitude, and power line conditions.

Operating temperature range: 32 to 104 F (0 to 40 °C)

Storage temperature range: -40 to 158 F (-40 to 70 °C)

Operating and storage altitude up to 15,000 feet (4600 m)

CE notice

EMC complies to EMC regulations and directives for emission and immunity to interference (EN 61326-1 Industrial, EN/IEC 61326-2-1).

Safety complies to applicable safety regulation IEC/EN 61010-1.

This product complies with directive 2011/65/EU.

Single-channel (portable / benchtop)

Weight: 6 lbs (2.72 kg) net, \leq 8 lbs (3.63 kg) shipping

Dimensions: 4.21 in H x 6.77 in W x 11.42 in L (incl. connectors) [124 mm H x 180 mm W x 305 mm L]

Multi-channel (rack-mountable) 19" 2U enclosure

Weight: 37 lbs (18 kg) net, \leq 8 lbs (25 kg) shipping

Dimensions:

Body: 3.4 in H x 16.8 in W x 18.9 in L [86 mm H x 444 mm W x 567mm L]

Front panel: 3.46 in H x 19.14 in W [88 mm H x 486.2mm W]

Recommended calibration cycle: 24 months